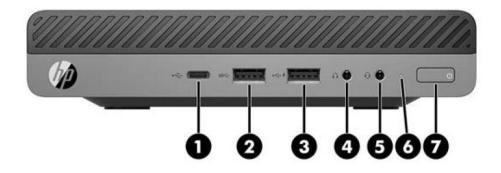
Overview

HP ProDesk 600 G3 Desktop Mini Business PC



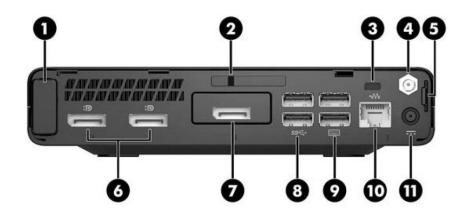
- 1. USB Type-C[™] charging port
- 2. USB 3.1 Gen 1 port
- 3. USB 3.1 Gen 1 charging port
- 4. Universal Audio Jack with CTIA headset support

- 5. Headset Connector
- 6. Hard drive activity light
- 7. Dual-state power button



Overview

HP ProDesk 600 G3 Desktop Mini Business PC



- 1. Antenna cover
- 2. Cover lock switch
- 3. Cable lock slot
- 4. External antenna connector
- 5. Padlock loop
- 6. (2) Dual-Mode DisplayPort[™] (DP++)

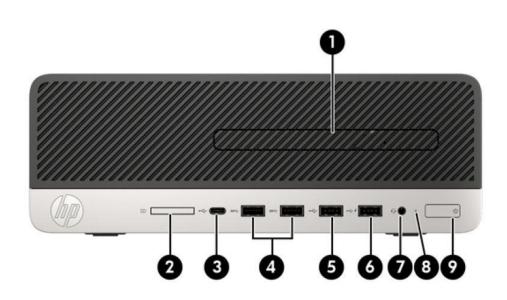
Not Shown

- Slots (1) internal M.2 PCIe 2230 connector for optional wireless NIC (1) internal M.2 SSD storage (2230 or 2280 connector)
- Bays (1) 2.5" internal storage drive bay
- VESA Support for VESA 100 mounting system on bottom of PC chassis

- Choice of port (DisplayPort[™], HDMI, VGA, Serial or USB-CTM) (USB-CTM option has alt mode DisplayPort[™] or 15W output)
- 8. (2) USB 3.1 Gen 1 (black)
- 9. (2) USB 3.1 Gen 1 (black), allows for wake from S4/S5 with keyboard/mouse when connected and enabled in BIOS
- 10. RJ-45 Network connector
- 11. Power connector



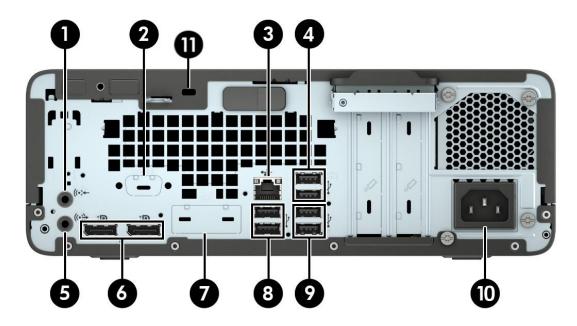
HP ProDesk 600 G3 Small Form Factor Business PC



- 1. Slim Optical Drive (optional)
- 2. SD card 4.0 reader (optional)
- 3. USB Type-C[™] charging port
- 4. (2) USB 3.1 Gen1 x ports
- 5. USB 2.0 port

- 6. USB 2.0 (fast charging port)
- 7. Universal Audio Jack with CTIA headset support
- 8. Hard drive activity light
- 9. Power button

Overview



HP ProDesk 600 G3 Small Form Factor Business PC

- 1. Audio-in connector
- 2. Optional serial port available
- 3. RJ-45 (network) jack
- 4. (2) USB 2.0 ports on non-vPro[™] SKUs
 (2) USB 3.1 Gen1 x ports on vPro[™] SKUs
- 5. Audio-out connector for powered audio devices
- 6. (2) Dual-Mode DisplayPort[™] (DP++)

- Optional port (DisplayPort[™], HDMI, VGA, or USB-C[™]) (USB-C[™] option has alt mode DisplayPort[™] or 15W output)
- 8. (2) USB 2.0 ports with wake from S4/S5 feature
- 9. (2) USB 3.1 Gen1 x ports
- 10. Power cord connector
- 11. Cable lock slot

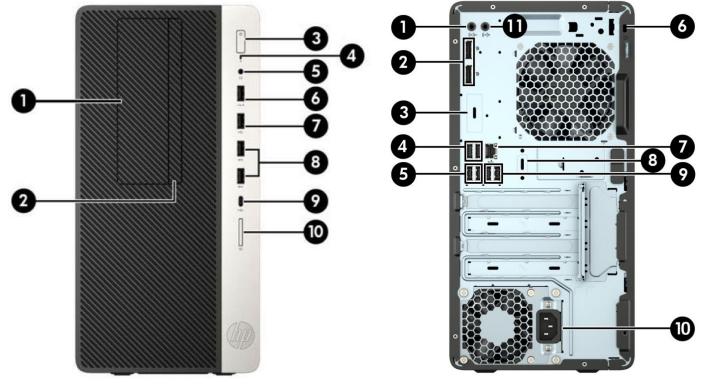
NOTE: The serial port is no longer standard to the chassis but is available as an option. A second serial port and PS/2 port PCIe combination are available.

<u>Not Shown</u>

- Slots (2) PCI Express x16 graphics connectors; one wired as an x4 (1) internal M.2 PCIe x1 connector for optional wireless NIC (1) internal M.2 PCIe x4 connector for optional Turbo Drive SSD
- Bays (1) 3.5" internal storage drive bay or 2.5" internal storage drive bay (2.5" drive needs adapter) (1) 9.5mm slim optical drive bay



Overview



HP ProDesk 600 G3 and 680 G3 Microtower Business PC

- 1. 5.25-inch drive bay (behind bezel)
- 2. Slim optical drive (optional)
- 3. Dual-state power button
- 4. Hard drive activity light
- 5. Universal Audio Jack with CTIA headset support
- 6. USB 2.0 (fast charging port*)
- 7. USB 2.0 port
- 8. (2) USB 3.1 Gen1 x ports
- 9. USB Type-C charging port
- 10. SD card 4.0 reader (optional)

- 1. Audio-in connector
- 2. Dual-Mode DisplayPort[™] (DP++) (2)
- 3. Optional port (DisplayPort[™], HDMI, VGA, or USB-CTM) (USB-CTM option has alt mode DisplayPort[™] or 15W output)
- 4. (2) USB 2.0 Ports with Wake from S4/S5 feature
- 5. (2) USB 3.1 Gen1 x ports
- 6. Cable lock slot
- 7. RJ-45 (network) jack
- 8. Optional serial port available
- (2) USB 2.0 ports on non-vPro[™] SKUs
 (2) USB 3.1 Gen1 x ports on vPro[™] SKUs
- 10. Power cord connector
- 11. Audio-out connector for powered audio devices

*This port connects a USB device, provides high-speed data transfer, and even when the computer is off, charges products such as a cell phone, camera, activity tracker, or smartwatch.

NOTE: When a device is plugged into the headset jack, a dialog box will open asking if you want to use the connector for a microphone line-in device or a headphone. You can reconfigure the connector at any time by double-clicking the Audio Manager icon in the Windows[®] taskbar.

The serial port is no longer standard to the chassis but is available as an option. A second serial port and PS/2 port PCIe combination are available.



Overview

Not Shown

- Slots (2) PCI Express x16 graphics connectors; one wired as an x4
 - (1) PCI Express x1 accessory connector
 - (1) PCI Express x1 accessory connector or PCI x1 accessory connector
 - (1) internal M.2 PCIe x1 connector for optional wireless NIC
 - (1) internal M.2 PCIe x4 connector for optional Turbo Drive SSD

NOTE: Select models will offer (1) PCI Express x1 accessory connector and (1) PCI connector instead of (2) PCI Express x1 accessory connectors

NOTE: Maximum total of 4 PCI slots supported on MT.

- Bays (1) 5.25" internal half-height drive bay or (2) 2.5" internal storage drive bays
 - (1) 3.5" internal storage drive bays
 - (1) 9.5mm internal optical drive bay



Overview

AT A GLANCE

- Choice of four form factors: Desktop Mini, Small Form Factor, Microtower and All-in-One Non-Touch only (AiO available 2H 2017)
- New commercial design on Desktop Mini, Small Form Factor, Microtower
- HP developed- and engineered UEFI BIOS supporting security, manageability and software image stability
- Intel[®] Q270 chipset supporting both Intel[®] 7 Generation and Intel[®] 6th generation Core[™] processors, featuring integrated Intel[®] HD Graphics and optional Intel[®] vPro[™] Technology (available with Core i5 and Core i7 processors)
- Processor support up to 65W (MT/SFF), 35W (DM)
- Support for Windows 10 to Windows 7 Downgrade with Intel[®] 6th Generation processors
- Intel[®] Ethernet Connection I219LM GbE LOM integrated network connection
- DDR4 Synchronous Dynamic Random Access Memory (SDRAM)
- Support for up to three monitors via two standard DisplayPort[™] connectors and an optional third video port connector which provides the following choices: HDMI, VGA (except AiO models), DisplayPort[™], or USB Type-C[™] with DisplayPort[™] (see Ports section or pages 1-8 for port availability by platform).
- Configurable 3rd rear I/O video port (HDMI, DisplayPort[™], VGA, Type-C with DisplayPort[™])
- HP BIOSphere Gen3
- HP Manageability Integration Kit
- HP WorkWise
- Standard and high efficiency energy saving power supply options
- ENERGY STAR[®] certified. EPEAT[®] Gold registered where applicable/supported. Registration may vary by country. See www.epeat.net for registration status by country.
- CCC, CECP & SEPA Certified
- PC chassis and all internal components and modules are manufactured with low halogen content³
- Arsenic-free
- Dust filter available for Desktop Mini, Small Form Factor, Microtower
- Protected by HP Services, including limited warranties up to 3-3-3 (terms and conditions vary by country; certain restrictions and exclusions apply); Care Packs available with up to 5 years Next Business Day Onsite Hardware Support
- Lengthy purchase lifecycles and image stability

NOTE: See important legal disclosures for all listed specs in their respective features sections.

- 1. Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. 64-bit computing system required. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.
- 2. DisplayPort[™] multi-stream monitors 'daisy-chained' together.
- 3. External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.

OPERATING SYSTEMS

Preinstalled

Windows 10 Pro 64¹ Windows 10 Pro 64 (National Academic License)³ Windows 10 Home 64¹ Windows 10 Home Single Language 64¹ Windows 7 Professional 64 (available through downgrade rights from Windows 10 Pro)^{2, 4} Windows 7 Professional 32 (available through downgrade rights from Windows 10 Pro)^{2, 4}

Pre-installed (other) FreeDOS 2.0 NeoKylin Linux® 64

Web-supported only Windows 10 Enterprise 64¹ Windows 7 Enterprise 64⁴

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

2. This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 10 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

3. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

4. Only available with 6th generation (Intel) processors.

CHIPSET

Intel® Q270

PROCESSORS*, **

*NOTE: Your product does not support Windows 8 or Windows 7, In accordance with Microsoft's support policy, HP does not support the Windows[®] 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows[®] 8 or Windows 7 drivers on http://www.support.hp.com

**Note: Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. 64-bit computing system required. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

Intel® 7th Generation Core™ i7 Processors	DM	<u>SFF</u>	<u>MT</u>
Intel [®] Core™ i7-7700 Processor		X	X
65W			
Up to 4.2 GHz Max. Turbo Frequency (3.6 GHz base frequency)			
8 MB cache, 4 cores, 8 threads			
Intel [®] HD Graphics 630			
Supports DDR4 memory up to 2400 MT/s data rate			
Supports Intel® vPro™ Technology and Intel® Stable Image			
Platform Program (SIPP)			



Intel [®] Core™ i7-7700T Processor	Х	
35W		
Up to 3.8 GHz Max. Turbo Frequency (2.9 GHz base frequency)		
8 MB cache, 4 cores, 8 threads		
Intel® HD Graphics 630		
Supports DDR4 memory up to 2400 MT/s data rate		
Supports Intel® vPro™ Technology and Intel® Stable Image		
Platform Program (SIPP)		

Intel® 7th Generation Core™ i5 Processors	DM	<u>SFF</u>	<u>MT</u>
Intel [®] Core™ i5-7500 Processor		Х	X
65W			
Up to 3.8 GHz Max. Turbo Frequency (3.4 GHz base frequency)			
6 MB cache, 4 cores, 4 threads			
Intel® HD Graphics 630			
Supports DDR4 memory up to 2500 MT/s data rate			
Supports Intel® vPro™ Technology and Intel® Stable Image			
Platform Program (SIPP)			
Intel [®] Core™ i5-7500T Processor	Х		
35W			
Up to 3.3 GHz Max. Turbo Frequency (2.7 GHz base frequency)			
6 MB cache, 4 cores, 4 threads			
Intel® HD Graphics 630			
Supports DDR4 memory up to 2400 MT/s data rate			
Supports Intel® vPro [™] Technology and Intel® Stable Image			
Platform Program (SIPP)			
Intel [®] Core™ i5-7600 Processor		Х	X
65W			
Up to 4.1 GHz Max. Turbo Frequency (3.5 GHz base frequency)			
6 MB cache, 4 cores, 4 threads			
Intel [®] HD Graphics 630			
Supports DDR4 memory up to 2400 MT/s data rate			
Supports Intel [®] vPro [™] Technology and Intel [®] Stable Image			
Platform Program (SIPP)			
Intel [®] Core™ i5-7600T Processor	Х		
35W			
Up to 3.7 GHz Max. Turbo Frequency (2.8 GHz base frequency)			
6 MB cache, 4 cores, 4 threads			
Intel® HD Graphics 630			
Supports DDR4 memory up to 2400 MT/s data rate			
Supports Intel® vPro™ Technology and Intel® Stable Image			
Platform Program (SIPP)			

Intel® 7th Generation Core™ i3 Processors	DM	<u>SFF</u>	<u>MT</u>
Intel [®] Core™ i3-7100 Processor		X	X
51W			
3.9 GHz base frequency			
3 MB cache, 2 cores, 4 threads			
Intel® HD Graphics 630			
Supports DDR4 memory up to 2400 MT/s data rate			
Intel [®] Core™ i3-7100T Processor	X		
35W			
3.4 GHz base frequency			



3 MB cache, 2 cores, 4 threads Intel® HD Graphics 630 Supports DDR4 memory up to 2400 MT/s data rate			
Intel® Core™ i3-7300 Processor 51W 4.0 GHz base frequency 4 MB cache, 2 cores, 4 threads Intel® HD Graphics 630 Supports DDR4 memory up to 2400 MT/s data rate		X	X
Intel [®] Core [™] i3-7300T Processor 35W 3.5 GHz base frequency 3 MB cache, 2 cores, 4 threads Intel [®] HD Graphics 630 Supports DDR4 memory up to 2400 MT/s data rate	x		
Intel® Core™ i3-7320 Processor 51W 4.1GHz base frequency 4 MB cache, 2 cores, 4 threads Intel® HD Graphics 630 Supports DDR4 memory up to 2400 MT/s data rate		X	X

Intel [®] 7th Generation Pentium [®] Processors	DM	<u>SFF</u>	<u>MT</u>
Intel [®] Pentium [®] G4560 Processor		Х	X
54W			
3.5 GHz Base Frequency			
3 MB cache, 2 cores, 4 threads			
Intel [®] HD Graphics 610			
Supports DDR4 memory up to 2400 MT/s data rate			
Intel [®] Pentium [®] G4560T Processor	X		
35W			
2.9 GHz Base Frequency			
3 MB cache, 2 cores, 4 threads			
Intel [®] HD Graphics 610			
Supports DDR4 memory up to 2400 MT/s data rate			
Intel [®] Pentium [®] G4600 Processor		Х	X
51W			
3.6 GHz Base Frequency			
3 MB cache, 2 cores, 4 threads			
Intel [®] HD Graphics 610			
Supports DDR4 memory up to 2400 MT/s data rate			
Intel [®] Pentium [®] G4600T Processor	X		
35W			
3.0 GHz Base Frequency			
3 MB cache, 2 cores, 4 threads			
Intel [®] HD Graphics 610			
Supports DDR4 memory up to 2400 MT/s data rate			
Intel [®] Pentium [®] G4620 Processor		Х	X
51W			
3.7 GHz Base Frequency			
3 MB cache, 2 cores, 4 threads			
Intel [®] HD Graphics 610			
Supports DDR4 memory up to 2400 MT/s data rate			



Intel® 7th Generation Celeron® Processors	DM	<u>SFF</u>	MT
Intel [®] Celeron [®] G3930 Processor		X	X
51W			
2.9 GHz Base Frequency			
2 MB cache, 2 cores, 2 threads			
Intel [®] HD Graphics 610			
Supports DDR4 memory up to 2133 MT/s data rate			
Intel [®] Celeron [®] G3930T Processor	X		
35W	A		
2.7 GHz Base Frequency			
2 MB cache, 2 cores, 2 threads			
Intel [®] HD Graphics 610			
Supports DDR4 memory up to 2133 MT/s data rate			
		V	v
Intel [®] Celeron [®] G3950 Processor		X	x
51W			
3.0 GHz Base Frequency			
2 MB cache, 2 cores, 2 threads			
Intel [®] HD Graphics 610			
Supports DDR4 memory up to 2133 MT/s data rate			
Intel® 6th Generation Core™ i7 Processors	DM	SFF	MT
Intel® Core™ i7-6700 Processor		X	X
65W		~	~
Up to 4.0 GHz Max. Turbo Frequency (3.4 GHz base frequency)			
8 MB cache, 4 cores, 8 threads			
Intel [®] HD Graphics 530			
Supports DDR4 memory up to 2133 MT/s data rate			
Supports Intel® vPro™ Technology and Intel® Stable Image			
Platform Program (SIPP)			
Intel [®] Core™ i7-6700T Processor	X		
35W	Λ		
Up to 3.6 GHz Max. Turbo Frequency (2.8 GHz base frequency) 8 MB cache, 4 cores, 8 threads			
Intel® HD Graphics 530			
Supports DDR4 memory up to 2133 MT/s data rate Supports Intel® vPro™ Technology and Intel® Stable Image			
Platform Program (SIPP)			
Intel® 6th Generation Core™ i5 Processors	DM	<u>SFF</u>	<u>MT</u>
Intel [®] Core™ i5-6500 Processor		X	Х
65W			
Up to 3.6 GHz Max. Turbo Frequency (3.2 GHz base frequency)			
6 MB cache, 4 cores, 4 threads			
Intel® HD Graphics 530			
Supports DDR4 memory up to 2133 MT/s data rate			
Supports Intel® vPro™ Technology and Intel® Stable Image			
Platform Program (SIPP)			
Intel [®] Core™ i5-6600T Processor	X		
35W			
Up to 3.5 GHz Max. Turbo Frequency (2.7 GHz base frequency)			
6 MB cache, 4 cores, 4 threads			
Intel [®] HD Graphics 530			
Supports DDP/ momory up to 2132 MT/s data rato		1	



Supports DDR4 memory up to 2133 MT/s data rate

Intel [®] Core™ i3-6100 Processor		X	X
Intel® 6th Generation Core™ i3 Processors	DM	<u>SFF</u>	MT
Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)			
Supports DDR4 memory up to 2133 MT/s data rate			
Intel® HD Graphics 530			
6 MB cache, 4 cores, 4 threads			
Up to 3.1 GHz Max. Turbo Frequency (2.5 GHz base frequency)			
35W			
Intel [®] Core™ i5-6500T Processor	x		
Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)			
Supports DDR4 memory up to 2133 MT/s data rate			
Intel [®] HD Graphics 530			
6 MB cache, 4 cores, 4 threads			
Up to 3.9 GHz Max. Turbo Frequency (3.3 GHz base frequency)			
65W			
Intel [®] Core™ i5-6600 Processor		Х	Х
Platform Program (SIPP)			
Supports Intel® vPro™ Technology and Intel® Stable Image			

	<u></u>	311	<u></u>
Intel [®] Core™ i3-6100 Processor		X	X
51W			
3.7 GHz base frequency			
3 MB cache, 2 cores, 4 threads			
Intel [®] HD Graphics 530			
Supports DDR4 memory up to 2133 MT/s data rate			
Intel [®] Core™ i3-6100T Processor	X		
35W			
3.2 GHz base frequency			
3 MB cache, 2 cores, 4 threads			
Intel [®] HD Graphics 530			
Supports DDR4 memory up to 2133 MT/s data rate			

Intel [®] 6th Generation Celeron [®] Processors	DM	<u>SFF</u>	<u>MT</u>
Intel [®] Celeron [®] G4400 Processor			X
54W			
3.3 GHz Base Frequency			
3 MB cache, 2 cores, 2 threads			
Intel [®] HD Graphics 510			
Supports DDR4 memory up to 2133 MT/s data rate			



MEMORY*

Form Factor	Туре	Maximum	Number of Slots
Desktop Mini	DDR4-2400 (Transfer rates up to 2400 MT/s)	32 GB	2 SODIMM
Small Form Factor	DDR4-2400 (Transfer rates up to 2400 MT/s)	64 GB	4 DIMM
Microtower	DDR4-2400 (Transfer rates up to 2400 MT/s)	64 GB	4 DIMM

Memory modules available. Memory options vary by platform. All slots are customer accessible / upgradeable.

- 2,048 MB (2048 MB x 1) (AMO only)
- 4,096 MB (4096 MB x 1)
- 8,192 MB (8192 MB x 1)
- 16,384 MB (16,384 MB x 1)

* Full availability of 4 GB or more of memory requires a 64-bit operating system. With Windows 32-bit operating systems, the amount of usable memory is dependent upon your configuration, so that above 3 GB all memory may not be available due to system resource requirements.

Memory modules support data transfer rates up to 2400 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

STORAGE*

2.5 inch 7.2k RPM Hard Disk Drives	<u>DM</u>	<u>SFF</u>	<u>MT</u>
1TB SATA	Х	Х	Х
500GB SATA	Х	Х	X
3.5" SATA 7.2k RPM Hard Disk Drives	<u>DM</u>	<u>SFF</u>	<u>MT</u>
500GB 7200RPM 3.5in		Х	Х
1TB 7200RPM 3.5in		Х	X
2TB 7200RPM 3.5in		Х	Х
2.5 inch Solid State Hybrid Drives (SSHD)	DM	<u>SFF</u>	<u>MT</u>
1TB 5400RPM 2.5in 8GB Hybrid	Х	Х	Х
500GB 5400RPM 2.5in 8GB Hybrid	X	Х	X
3.5 inch Solid State Hybrid Drives (SSHD)	DM	<u>SFF</u>	<u>MT</u>
1TB 7200RPM 3.5in SSHD (SSHD)		Х	Х
2.5 inch Self-encrypting Drives (SED HDD)	DM	<u>SFF</u>	<u>MT</u>
500GB 5400RPM 2.5in Federal Information Processing Standard (FIPS) SED	X	X	Х
500GB 7200RPM 2.5in SED 0PAL2	Х	Х	Х



2.5 inch Self-encrypting Drives (SED SSD)	DM	<u>SFF</u>	<u>MT</u>
256GB TLC SED SSD Opal 2 Drive	Х	Х	Х
512GB TLC SED SSD Opal 2 Drive	Х	Х	Х
256GB TLC SED SSD 2.5in Federal Information Processing Standard (FIPS) SED	x	X	X
512GB TLC SED SSD 2.5in Federal Information Processing Standard (FIPS) SED	X	X	Х

PCIe NMVe SSD Drives	<u>DM</u>	<u>SFF</u>	<u>MT</u>
HP 256GB Turbo Drive G2 PCIe TLC SSD Drive	Х	Х	X
HP 512GB Turbo Drive G2 PCIe TLC SSD Drive	Х	Х	X
HP 1TB Turbo Drive G2 PCIe TLC SSD Drive	Х	Х	Х

2.5 SATA SSD Drives	DM	<u>SFF</u>	<u>MT</u>
HP SATA 128GB SSD Drive	Х	Х	X
HP SATA 256GB SSD Drive	Х	Х	Х

*For storage drives, GB = 1 billion bytes, TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB of system disk is reserved for system recovery software.

Optical Disc Drives	DM	<u>SFF</u>	<u>MT</u>
HP 9.5mm G3 800/600 Tower DVD-Writer*			X
HP 9.5mm G3 800/600 Tower DVD-ROM			Х
HP 9.5mm G3 800/600/400 SFF G4 400 Microtower DVD-Writer*		Х	
HP 9.5mm G3 800/600/400 SFF G4 400 Microtower DVD-ROM		Х	

*HD-DVD discs cannot be played on this drive. No support for DVD-RAM. Actual speeds may vary. Don't copy copyright-protected materials. Double Layer discs can store more data than single layer discs. Discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

Ren	novable	<u>DM</u>	<u>SFF</u>	<u>MT</u>
	HP 9.5mm Slim Removable SATA 500GB		Х	Х
	HP 3.5" Removable SATA HDD Frame/Carrier			Х

Media Card Reader (optional)*	DM	<u>SFF</u>	<u>MT</u>
SD4 with 5-in-1 Interface from SD option to PCA is USB (Supports SD, SDXC, SDHC, UHS-I, UHS-II)		х	X

*Card sold separately



GRAPHICS

/stem Integrated Graphics	DM	<u>SFF</u>	<u>MT</u>
Intel® HD Graphics 530 (integrated on 6 th gen Core i7/i5/i3 processors)	Х	Х	Х
Intel® HD Graphics 630 (integrated on 7 th gen Core i7/i5/i3 processors and Pentium G4620, 4600, 4600T)	Х	Х	Х
Intel® HD Graphics 610 (integrated on Pentium G4560, G4560T, Celeron G3950, G3930, G3930T)	Х	Х	Х

Optional Discrete Graphics Solutions

(optional and RX 460 devices and GT 730 1GB HDMI card, they must

be configured at purchase)	<u>DM</u>	<u>SFF</u>	<u>MT</u>
AMD Radeon™ R7 450 4GB FH PCIe x16*			Х
AMD Radeon™ RX 460 2GB FH PCIe x16*			Х
NVIDIA® GeForce® GT 730 1GB PCIe x8 HDMI		Х	Х
NVIDIA® GeForce® GT 730 2GB PCIe x8 DP		Х	Х

*Requires 250W chassis

2 nd Graphics Cards	DM	<u>SFF</u>	<u>MT</u>
AMD Radeon™ R7 450 4GB FH PCIe x16 G5 2 ^{nd**}			Х
NVIDIA [®] GeForce [®] GT 730 1GB PCIe x8 HDMI 2 ^{nd***}			Х
NVIDIA [®] GeForce [®] GT 730 2GB PCIe x8 DP 2 ^{nd****}			Х

**Available only with AMD Radeon™ R7 450.

***Available only with NVIDIA® GeForce® GT730 1GB.

****Available only with NVIDIA® GeForce® GT730 2GB.

AUDIO/MULTIMEDIA

	<u>DM</u>	<u>SFF</u>	<u>MT</u>
Conexant CX20632 Audio Codec	Х	Х	Х
Headset* front connector (3.5mm)	Х	Х	Х
Headphone front connector (3.5mm)	Х		
Line-out rear connector* (3.5mm)		Х	Х
Line-in rear connector* (3.5mm)		Х	Х
Multi-streaming capable*	Х	Х	Х
Internal speaker (standard)	Х	Х	Х

* The DM, SFF, MT front headset connector supports CTIA style headsets. Headset connectors are retaskable to function as a Line-In, Microphone-In, Line-out or Headphone-out port. Rear audio input ports are re-taskable as a Line-in or Microphone-in port. External speakers must be powered externally. Multi-streaming can be enabled in the audio control panel to allow independent audio streams to be sent to/from the front and rear jacks. This allows for different audio applications to use separate audio ports on the system. For example, the front jacks could be used with a headset for a communications application while the rear jacks are being used with external speakers and a multimedia application.



NETWORKING/COMMUNICATIONS*

Ethernet (RJ-45) Integrated	DM	<u>SFF</u>	<u>MT</u>
Intel [®] I219LM Gigabit Network Connection LOM (standard	Х	Х	Х
Ethernet (RJ-45) Optional Intel® Ethernet I210-T1 PCIe x1 Gb Network Interface Card (optional)	<u>DM</u>	<u>SFF</u> X	<u>мт</u> Х
		^	^
Wireless LAN (optional and all except for 7265 for SFF/MT must be bought at purchase)	DM	<u>SFF</u>	<u>MT</u>
Intel® 8265 802.11AC 2x2 Wi-Fi +Bluetooth [®] M.2 Combo Card vPro™ (802.11AC Wave 2 supported)	Х	Х	Х
Intel® 8265 802.11AC 2x2 Wi-Fi +Bluetooth [®] M.2 Combo Card non-vPro™ (802.11AC Wave 2 supported)	Х	Х	Х
Intel® 7265 802.11AC 2x2 Wi-Fi +Bluetooth® M.2 Combo Card non-vPro™	Х	Х	Х
Intel® 7260 802.11 a,b,g,n 2x2 M.2 Bluetooth® Disabled NIC**	Х		
Intel® 3168 802.11AC 2x2 Wi-Fi +Bluetooth [®] M.2 Combo Card non-vPro™	Х	Х	Х
* Wireless access point and Internet service required and not included. Availability of publ	ic wireles	s access i	noints

* Wireless access point and Internet service required and not included. Availability of public wireless access points limited.

**Wake on Lan feature is not available.

SLOTS

	DM	<u>SFF</u>	<u>MT</u>
Turbo Drive (M.2 PCIe)	1 ea. M.2 PCIe x1-2230 (for WLAN) 1 ea. M.2 PCIe x4-2280/2230 (for storage)	1 ea. M.2 PCIe x1-2230 (for WLAN) 1 ea. M.2 PCIe x4-2280 (for storage)	1 ea. M.2 PCle x1-2230 (for WLAN) 1 ea. M.2 PCle x4-2280 (for storage)
PCI Express x1 (v3.0)	N/A	N/A	2 ea.* (1 optional)) 4.2" full height 6.6" length 10W max. power
PCI Express x16 (v3.0) (wired as a x4)	N/A	1 ea. 2.5" low profile 6.6" length 35W max. power	1 ea. 4.2" full height 6.6" length 35W max. power
PCI Express x16 (v3.0)	N/A	1 ea. 2.5" low profile 6.6" length 35W max. power	1 ea. 4.2" full height 6.6" length 75W max. power
Optional PCI	N/A	N/A	1 ea. 4.2" full height 6.6" length

*Models configured with optional PCI slot come with 1 PCI Express x16 (v3.0) (wired as a x4) instead of 2. NOTE: Maximum total of 4 PCI slots supported on MT.



PORTS

vPro™ configs	DM	<u>SFF</u>	<u>MT</u>
USB 2.0	N/A	2 (front) including 1 fast charging; 2 (rear)	2 (front) including 1 fast charging; 2 (rear)
USB 3.1 Gen1	2 (front) including 1 fast charging; 4 (rear)	2 (front); 4 (rear)	2 (front); 4 (rear)
USB Type-C™3.1 Gen1 port	1 (front); 1 (optional) (rear)	1 (front); 1 (optional) (rear)	1 (front); 1 (optional) (rear)

Non-vPro™ configs	DM	<u>SFF</u>	<u>MT</u>
USB 2.0	N/A	2 (front) including 1 fast charging; 4 (rear)	2 (front) including 1 fast charging; 4 (rear)
USB 3.1 Gen1	2 (front) including 1 fast charging; 4 (rear)	2 (front); 2 (rear)	2 (front); 2 (rear)
USB Type-C™3.1 Gen1 port	1 (front); 1 (optional) (rear)	1 (front); 1 (optional) (rear)	1 (front); 1 (optional) (rear)
USB 2.0	N/A	2 (front) including 1 fast charging; 4 (rear)	2 (front) including 1 fast charging; 4 (rear)

Video	HDMI, VGA or USB-C [™]) (USB- C [™] option has alt mode	stream 1 Optional port (DisplayPort™, HDMI, VGA or USB-C™) (USB- C™ option has alt mode	2 DisplayPort™ with multi-stream 1 Optional port (DisplayPort™, HDMI, VGA or USB-C™) (USB- C™ option has alt mode DisplayPort™ or 15W output)
Audio			Front: 1 Headset Rear: 1 Audio-out 1 Audio-in
Network Interface	RJ-45	RJ-45	RJ-45
Serial (RS-232)	1 (optional)*	1 (optional)	1 (optional)
Serial (RS-232) and PS/2 combination	N/A	1 (optional) (rear)	1 (optional) (rear)

BAYS

	DM	SFF	<u>MT</u>
5.25" Half Height ODD	N/A	N/A	1 ea.
9mm Slim ODD	N/A	1 ea.	1 ea.
Secure Digital (SD) 4 Reader	N/A	1 ea.	1 ea.
2.5" internal storage drive	1 ea.	1 ea.*	2 ea.
3.5" internal storage drive	N/A	1 ea.*	1 ea.

*SFF can be configured with either (1) 3.5" or (1) 2.5" internal storage drive (2.5 inch drive needs adapter)

KEYBOARDS AND POINTING DEVICES (optional)



Keyboards	DM	<u>SFF</u>	<u>MT</u>
HP Conferencing Keyboard	X	Х	Х
HP USB PS/2 Washable Keyboard*	Х	Х	Х
HP USB Business Slim CCID SmartCard Keyboard	Х	Х	Х
HP USB Business Slim Keyboard	Х	Х	Х
HP PS/2 Business Slim Keyboard*		Х	Х
HP USB Business Slim Keyboard (China only)	Х	Х	Х
HP USB Business Slim Grey Keyboard	Х	Х	Х
Mice	DM	<u>SFF</u>	MT
HP PS/2 Mouse*		Х	Х
HP USB 1000dpi Laser Mouse	Х	Х	Х
HP Grey V2 Mouse	Х	Х	X.
HP USB Mouse	Х	Х	Х
HP USB PS/2 Washable Mouse*	Х	Х	Х
HP USB Mouse (China only)	Х	Х	Х
HP USB Hardened Mouse	Х	Х	Х
Combo	DM	<u>SFF</u>	MT
HP Wireless Business Slim Keyboard and Mouse	X	Х	Х
HP USB Keyboard and Mouse (China only)	Х	Х	Х
Other	DM	<u>SFF</u>	MT
HP Mouse Pad	Х	Х	Х
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*Optional HP Internal Serial/PS/2 Ports is required to support this device.

ADAPTERS AND CABLES (optional)

	<u>DM</u>	<u>SFF</u>	<u>MT</u>
HP DisplayPort™ Cable	Х	Х	Х
HP DisplayPort™ to DVI-D Adapter	Х	Х	Х
HP DisplayPort™ to HDMI 4K Adapter	Х	Х	X
HP DisplayPort™ to VGA Adapter	Х	Х	Х
HP DVI Cable	Х	Х	X
HP 700mm DisplayPort™ Cable Kit	Х		
HP USB to Serial Port Adapter	Х		

I/O Devices

Optional Ports (only one can be chosen) must be configured at purchase except for PCIe x1 cards.

	DM	<u>SFF</u>	<u>MT</u>
HP DisplayPort™ Port	Х	Х	Х
HP Type-C Port	Х	Х	Х
HP HDMI Port	Х	Х	Х
HP VGA Port	Х	Х	Х
HP Internal Serial Port		Х*	X*
HP Internal Serial/PS/2 Ports		Х*	X*
HP PCIe x1 Parallel Port Card		Х	X
HP PCIe x1 SuperSpeed USB 3.1 Gen 2 Type-C Card		Х	Х

DUST FILTERS

	DM	<u>SFF</u>	<u>MT</u>
HP ProDesk 600 G3 Microtower Dust Filter			Х
HP ProDesk 600/400 G3 SFF Dust Filter		Х	
HP G3 Mini Dust Filter	Х		

* Internal Serial Port and HP Internal Serial/PS/2 Ports can both be selected for MT and SFF

DESKTOP MINI ACCESSORIES (optional)

	DM	<u>SFF</u>	<u>MT</u>
HP Desktop Mini DVD-Writer ODD Expansion Module	Х		
HP Desktop Mini 500GB HDD/ I/O Expansion Module	Х		
HP Desktop Mini I/O Expansion Module	Х		
HP Desktop Mini Security/Dual VESA Sleeve	Х		
HP DM VESA Power Supply Holder	Х		
HP DM VESA Quick Deploy Adhesive	Х		
HP Desktop Mini Vertical Chassis Stand	Х		
HP Desktop Mini Port Cover Kit	Х		
HP Quick Release Bracket	Х		
HP DM Antenna/Wiring WLAN Kit	Х		

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

BIOS

HP BIOSphere Gen3¹ HP DriveLock | HP Automatic DriveLock BIOS Update via Network Master Boot Record Security Power On Authentication Secure Erase² Absolute Persistence Module³ Pre-boot Authentication



HP LAN-WLAN Protection HP Wireless Wakeup

Multi Media

CyberLink Power Media Player (select models only) CyberLink Power2Go (select models only)

Communication / Connectivity

Native Miracast Support⁴

HP Value Add Software

HP ePrint Driver + JetAdvantage⁵ HP Hotkey Support - CMIT HP Recovery Manager HP Recovery Disc Creator (Windows 7 only) HP Jumpstart HP Support Assistant HP Noise Cancellation Software HP Velocity HP Notifications

3rd Party

Foxit PhantomPDF Express for HP (Windows 7 only)

Microsoft Products

Buy Office Bing Search Skype⁶

Manageability

HP Driver Packs⁷ HP SoftPaq Download Manager (SDM) HP System Software Manager (SSM)⁷ HP BIOS Config Utility (BCU)⁷ HP Client Catalog⁸ HP Manageability & Integration Kit (MIK)⁷ LANDESK Management⁸

For more information on HP Client Management Solutions refer to: http://www.hp.com/go/clientmanagement

Client Security Software

HP Client Security

- HP Security Manager (including Credential Manager and Password Manager)
- HP Drive Lock
- HP Password Manager
- Absolute Persistence Module
- Power On Authentication

Microsoft Security Essentials⁹ (Windows 7 only) Microsoft Defender HP WorkWise (requires Bluetooth[®])¹⁰

Standard

Trusted Platform Module (TPM) 2.0 (Infineon SLB9670). Common Criteria EAL4+ Certified.



Downgradeable to TPM 1.2. Convertible to FIPS 140-2 Certified mode. (TPM 2.0 is not available for Win 7 32-bit.) Restrictions apply; contact your account manager for more details.

For more information on HP Client Security Software Suite, refer to http://www.hp.com/go/clientsecurity.

1 HP BIOSphere Gen 3 requires Intel® or AMD 7th generation processors.

- 2 For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.
- 3 Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

4 Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast

- 5 Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/eprintcenter). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.
- 6 Skype is not offered in China.
- 6 Not preinstalled, however available for download at http://www.hp.com/go/clientmanagement
- 7 Subscription required.
- 9 Opt in and internet connection required for updates.

10 HP WorkWise smartphone app will soon be available as a free download on the App Store and Google Play. Requires Windows 10 Build 1607 or higher).

HP BIOS

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP Pro 600 G3 Business PC into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 14 languages.
- Update your BIOS via the cloud or standardize on a BIOS version hosted on Enterprise network.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification 2.5
- Absolute Persistence agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within Windows (HPBIOSUPDREC), HP Client Manager, and fail-safe recovery. In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS software and from the support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS Features:

• Power-On password – Helps prevent an unauthorized user from powering on the system.



- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and configuration management, allowing operating systems and applications to manage power based on activity and usage. HP Pro models use ACPI to provide power conservation features.

S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 0.5W in S5 (when turned off). When S5 Max Power Savings feature is enabled below features are turned off:

- Power to slots
- Wake events other than power buttons (such as Wake on LAN)
- USB charging ports

Core™ vPro™ Processors*

Intel[®] 6th & 7th Generation Core[™] vPro[™] Processors

All HP Pro 600 G3 Business PC models featuring this technology include processors that are part of the Intel[®] Stable Image Platform Program (SIPP) designed to ensure the stability promise inherent in the value proposition of the HP Pro 600 G3 Business PC, thus making these models the most stable, secure, and manageable platforms available to enterprises today.

Intel® Advanced Management Technology (AMT) v11** – An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 11 includes the following advanced management functions:

- Support for configuration of Intel[®] AMT 11.0 new capabilities
- No reset after provisioning
- Support changes to BIOS table 130
- Support for Microsoft Windows Server 2012 R2
- Support for New Microsoft SQL Server Versions including Standard and Enterprise editions
- Support for Intel[®] SSD Prop 2500 Series
- Support for Intel[®] Enterprise Digital Fence
- The Platform Discovery Utility can now discover these additional Intel[®] products:
- Intel[®] SSD Pro 2500 Series; Enterprise Digital Fence
- Intel[®] Identity Protection Technology with One Time Password; Public Key Infrastructure; Multi Factor Authentication
- Intel[®] Identity Protection Technology with Intel[®] WiGig
- New Profile Editor and Profile Editor Plugin Interface
- New Required Permissions for Solutions Framework

*Some functionality of this technology, such as Intel Active management technology and Intel[®] Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Intel vPro™ technology is dependent on 3rd party software providers. Compatibility with future "virtual appliances" is yet to be determined.

** Intel® Active Management Technology requires an Intel® AMT-enabled chipset, network hardware and software, as well as connection with a power source and a corporate network connection. Setup requires configuration by the purchaser and may require scripting with the management console or further integration into existing security frameworks to enable certain functionality. It may also require modifications of implementation of new business processes.



HARDWARE SECURITY

SATA 0,1 port disablement (via BIOS)

Serial, USB enable/disable (via BIOS)

Solenoid Lock / Hood Sensor (MT/SFF only)

Hood Sensor for DM (integrated in the PCA, can be enabled/disabled through BIOS)

Support for chassis padlocks and cable lock devices

POWER SUPPLY

	DM	SFF	МТ
Standard Efficiency	65W EPS, 89% average efficiency at 115V & 230Vac	N/A	N/A
80 PLUS Bronze	N/A	180W active PFC 82/85/82% efficient at 20/50/100% load (115V)	180W active PFC 82/85/82% efficient at 20/50/100% load (115V) 250W active PFC 82/85/82% efficient at 20/50/100% load (115V)
80 PLUS Gold	N/A	N/A	N/A
80 PLUS Platinum	N/A	180W active PFC 90/92/89% efficient at 20/50/100% load (115V) 91/93/90% efficient at 20/50/100% load (230V)	250W active PFC 90/92/89% efficient at 20/50/100% load (115V) 91/93/90% efficient at 20/50/100% load (230V)
Operating Voltage Range	90 – 264 VAC	90 – 264 VAC	90 – 264 VAC
Rated Voltage Range	100-240V AC	100-240V AC	100-240V AC
Rated Line Frequency	50/60 HZ	50/60 HZ	50/60 HZ
Operating Line Frequency	47 – 63 Hz	47 – 63 Hz	47 – 63 Hz
Rated Input Current	N/A	N/A	N/A
Rated Input Current with Energy Efficient* Power Supply		180W/2.3A	180W/2.3A 250W Bronze/3.5A 250W Platinum/3A
DC Output			



	+19.5V	+12.1V	+12.1V
Current Leakage (NFPA 99: 2102)	Less than 500 microamps of leakage current at 120 Vac with the ground wire disconnected, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1.	contact patients in normal use. Per section 10.3.5.1.	
	Less than 100 microamps of leakage current at 120 Vac with the ground wire intact with normal polarity, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1.		
Power Supply Fan	N/A	70mm variable speed	70mm variable speed
Power cord length	6.0 ft. (1.83 m)	6.0 ft. (1.83 m)	6.0 ft. (1.83 m)
External Power Adapter	N/A	N/A	N/A
Dimensions	N/A	N/A	N/A
Total Cord Length	N/A	N/A	N/A

WEIGHTS & DIMENSIONS

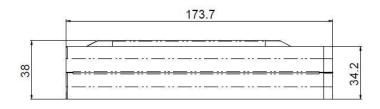
	DM	<u>SFF</u>	<u>MT</u>
Chassis (W x H x D)	6.97 x 1.35 x 6.88 in	10.6 x 3.7 x 11.7 in	6.69 x 12.13 x 10.8 in
Not including bezel	177 x 34.2 x 174.7 mm	270 x 95 x 296 mm	170 x 338 x 274 mm
System Volume	64 cu in	463 cu in	960 cu in
	1.06 L	7.6 L	15.74 L
System Weight*	2.67 lb	9.98 lb	15.77 lb
	1.21 kg	4.53 kg	7.14 kg
Max Supported Weight	N/A	77 lb	77 lb
(desktop orientation)		35 kg	35 kg
Packaging (H x W x D)	5.7 x 9.1 x 19.6 in	19.65 x15.71 x 9.06 in	19.65 x 15.35 x 11.73 in
	144.8 x 231.1 x 497.8 mm	499 x 399 x 230 mm	499 x 390 x 298 mm
Shipping Weight	6.1 lb	16.12 lb.	22.64 lb.
	2.8 kg	7.32 kg	10.28 kg
Palletization Profile	20-units per layer	6-units per layer	6-units per layer
	4 layer max	10 layer max	7 layer max
	80-units per pallet	60 per pallet	42 per pallet
	Footprint-39.21 x 46.61 in (996	47.24 x 39.37 x 94.49 in (including	47.24 x 39.37 x 86.85 in
	x 1184 mm)	pallet)	(including pallet)

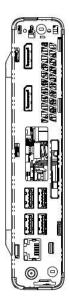


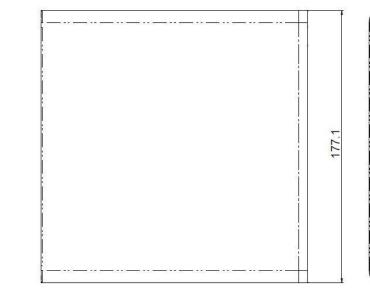
Standard Features and Configurable Components

Dependent on 40-Ft Stnd. Sea Container or 40-Ft High-cube Sea Container is used)		
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DESKTOP MINI DIMENSIONS



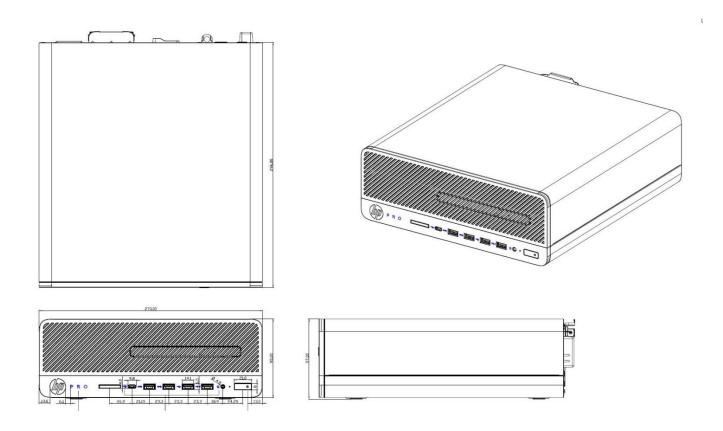






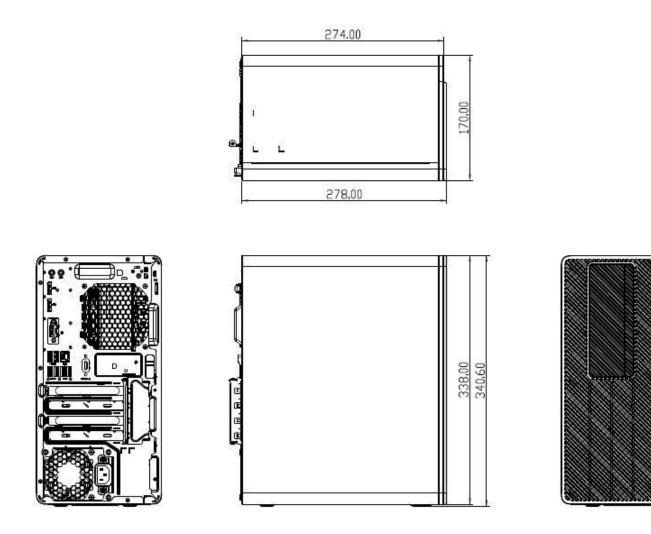


SMALL FORM FACTOR DIMENSIONS





MICROTOWER DIMENSIONS





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PROPER

ENVIRONMENTAL & INDUSTRY

ENERGY STAR[®] certified models available

EPEAT® registered where applicable/supported. See http://www.epeat.net for registration status by country. Low halogen (chassis, all internal components and modules)* TAA compliant models available * External power supplies, power cords, cables and peripherals are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.

UNIT ENVIRONMENT AND OPERATING CONDITIONS

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range	Operating: 50° to 95° F (10° to 35° C)* Non-operating: -22° to 140° F(-30° to 60° C)
Relative Humidity	Operating: 10% to 90% (non-condensing at ambient) Non-operating: 5% to 95% (non-condensing at ambient)
Maximum Altitude (unpressurized)	Operating: 5000m Non-operating: 50000ft (15240 m)

*Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

SERVICE AND SUPPORT

On-site Warranty¹: Three-year (3-3-3) limited warranty delivers three years of on-site, next business day ² service for parts and labor and complimentary limited technical support.³ Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing an optional HP Care Pack.⁴ To choose the right level of service for your HP product, visit HP Care Pack Central: www.hp.com/go/cpc

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured and third-party HP qualified hardware and software.



NOTE 4: Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



Technical Specifications – Graphics

GRAPHICS

DicalauDortM	Multimodo conchias avera	te LIDCD Dieplass Dant Assetta (a	strooms) LIDDO link water av d						
DisplayPort™	Multimode capable; supports HDCP, Display Port Audio (2 streams), HBR2 link rates and Multi-Stream Technology for a maximum of 3 displays (including the integrated panel)								
Memory	The BIOS has options for se	electing the dedicated memory	size of 128MB, 256MB or 512MB						
			ing Intel's Dynamic Video Memory en graphics and system memory						
Maximum Graphics Memory	Microsoft Windows 7	Windows 8.1	Windows 10						
	Up to 1.7GB	Up to 1.8GB	>4 GB						
		maximum graphics memory ca r computer's configuration.	an be less than the amounts listed						
Maximum Color Depth	32 bits/pixel								
Graphics/Video API Support	playback and enha experience Encode/ti Playback Superior i DirectX Video Acce Full AVC/ Advanced Schedul Windows 7, Windo DirectX 12.1 OpenGL 4.4 Open CL 1.2 (Intel®	ntel® Clear Video Technology H ancement features that improv ranscode HD content of high definition content inclu image quality with sharper, mo eleration (DXVA) support for ac VC1/MPEG2/HEVC HW Decode er 2.0, 1.0 ws 8.1, Windows 10, Linux OS S	ding Blu-ray Disc ore colorful images celerating video processing						

Supported Display Resolutions and Refresh Rates

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP. For All in One platforms, resolutions higher than the integrated panel resolution are not supported on the integrated panel.

		VGA	DisplayPort™	HDMI	
Resolution	Refresh Rate				Standard
640 x 480	60, 75, 85	х	х	Х	VESA DMT, CVT 0.31M3
720 x 400	70	Х	х	х	IBM VGA
800 x 600	60, 75, 85	Х	х	Х	VESA DMT, CVT0.48M3



Technical Specifications – Graphics

1024 x 768	60, 75, 85	х	х	Х	VESA DMT, CVT 0.79M3
1152 x 864	60, 75, 85	х	х	Х	VESA DMT, CVT 0.83MA
1280 x 720	60, 75, 85	х	х	Х	VESA DMT, CVT 0.92M9, CEA-770.3
1280 x 768	60, 60RB, 75, 85	х	х	Х	VESA DMT, CVT 0.98M9/0.98M9-R
1280 x 800	60, 75, 85	х	х	х	VESA DMT
1280 x 960	60, 75, 85	Х	х	х	VESA DMT
1280 x 1024	60, 75, 85	х	х	Х	VESA DMT, CVT 1.31M4
1366 x 768	60, 60RB	х	х	х	VESA DMT
1440 x 900	60, 60RB	Х	х	х	VESA DMT
1600 x 900	60, 60RB, 75, 85	х	х	Х	VESA DMT
1680 x 1050	60, 60RB, 75	х	х	х	VESA DMT, CVT 1.76MA/1.76MA-R
1920 x 1080	60	х	х	х	VESA DMT, CVT 2.07M9, SMPTE 274M
1920 x 1200	60, 60RB, 75, 85	Х*	х	х	DMT, CVT 2.30MA/2.30MA-R
1600 x 1200	60, 75, 85	Х*	х	х	VESA DMT, 1.92M3
1920 x 1440	60, 75, 85		х	х	VESA DMT, CVT 2.76M3
2048 x 1536	60,75		х	х	CVT 3.15M3
2560 x 1440	59.951		х	х	CVT 3.69M9-R
2560 x 1600	60, 60RB		х	х	VESA DMT, CVT 4.10MA/4.10MA-R
3840 x 2160	24		х	х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	25		х	х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	30		х	х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	50		х	х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	60		х	х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
4096 x 2160	24		х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	25		х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	30		х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	50		х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	60		х	х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
1920 x 1080	60	1	х	х	VESA (SMPTE 274M)
1920 x 1080	50	1	х	х	SMPTE 274M
1920 x 1080	30	1	х	х	SMPTE 274M
1920 x 1080	24	1	х	х	SMPTE 274M
1280 x 720	60		х	Х	VESA (CEA-770.3)
1280 x 720	50	1	х	х	SMPTE 296M



Technical Specifications – Graphics

720 x 576	50	x	v			
		^	Х	ITU-R BT.1358		
640 x 480	60	х	х	CEA (VESA DMT)		
* 60Hz refresh rate only on VGA						

AMD Radeon™ R7 450 4GB PCIe x16 Graphics Card

Memory	4GB 128-bit wide frame buffer operating at 1125MHz.
Controller Clock Speed	AMD® Radeon™ R9 350 GPU operating at 925 MHz
Multi-display Support	A maximum of 4 displays are supported by the card. A maximum of 2 legacy displays (Native VGA, DVI, or displays connected with passive DisplayPort™ adapters are considered as legacy)
Graphics /API support	DIRECTX 12, Open GL 4.3, Open CL1.2, UVD 3
Output Connectors	1 x Dual-Link DVI-I, 1x DisplayPort™; 1x HDMI; Includes DVI to VGA adapter

Supported Display Resolutions and Refresh Rates

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

		Lotuepe (DA1-ACU) ACU	DVI-D	DisplayPort™	HDMI	
Resolution	Refresh Rate*					Standard
640 x 480	60, 75, 85	Х	Х	х	Х	VESA DMT, CVT 0.31M3
720 x 400	70	Х	Х	Х	Х	IBM VGA
800 x 600	60, 75, 85	Х	Х	Х	Х	VESA DMT, CVT0.48M3
1024 x 768	60, 75, 85	Х	Х	Х	Х	VESA DMT, CVT 0.79M3
1152 x 864	60, 75, 85	Х	Х	Х	Х	VESA DMT, CVT 0.83MA
1280 x 720	60, 75, 85	Х	Х	Х	Х	VESA DMT, CVT 0.92M9, CEA-770.3
1280 x 768	60, 60RB, 75, 85	Х	Х	Х	Х	VESA DMT, CVT 0.98M9/0.98M9-R
1280 x 800	60, 75, 85	Х	Х	Х	Х	VESA DMT
1280 x 960	60, 75, 85	Х	Х	Х	Х	VESA DMT
1280 x 1024	60, 75, 85	Х	Х	Х	Х	VESA DMT, CVT 1.31M4
1366 x 768	60, 60RB	Х	Х	Х	Х	VESA DMT
1440 x 900	60, 60RB	Х	Х	Х	Х	VESA DMT
1600 x 900	60, 60RB, 75, 85	Х	Х	Х	Х	VESA DMT
1680 x 1050	60, 60RB, 75	Х	Х	Х	х	VESA DMT, CVT 1.76MA/1.76MA-R
1920 x 1080	60	Х	Х	х	х	VESA DMT, CVT 2.07M9, SMPTE 274M
1920 x 1200	60, 60RB, 75, 85	Х	Х	х	х	DMT, CVT 2.30MA/2.30MA-R
1600 x 1200	60, 75, 85	Х	Х	х	х	VESA DMT, 1.92M3
1920 x 1440	60, 75, 85	Х	Х	Х	х	VESA DMT, CVT 2.76M3



Technical Specifications – Graphics

2048 x 1536	60,75	х	Х	Х	х	CVT 3.15M3
2560 x 1440	59.951		Х	Х	x	CVT 3.69M9-R
2560 x 1600	60, 60RB		Х	Х	х	VESA DMT, CVT 4.10MA/4.10MA-R
3840 x 2160	24			Х	х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	25			Х	х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	30		Х	Х	х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	50			Х		CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	60			Х		CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
4096 x 2160	24			Х	х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	25			Х	х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	30			Х	х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	50			Х		CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	60			Х		CVT-RBv1/v2 (8.85M-R), SMPTE 274M
1920 x 1080	60		Х	Х	х	VESA (SMPTE 274M)
1920 x 1080	50		Х	Х	х	SMPTE 274M
1920 x 1080	30		Х	Х	х	SMPTE 274M
1920 x 1080	24		Х	х	x	SMPTE 274M
1280 x 720	60		Х	х	x	VESA (CEA-770.3)
1280 x 720	50		Х	х	x	SMPTE 296M
720 x 480	60		Х	х	x	MHL (CEA-770.2)

* >60 refresh rates only for analog (VGA) signaling

AMD Radeon™ RX 460 4GB FH PCIe x16 Graphics Card

Memory	2GB 128-bit wide frame buffer operating at 1750MHz.
Controller Clock Speed	AMD [®] Radeon™ RX 360 GPU operating at up to 1.2GHz
Multi-display Support	A maximum of 4 displays are supported by the card.
Graphics /API support	DIRECTX 12, Open GL 4.5, Open CL 2.0, AMD Video Coding Engine (VCE) 3.4 and AMD Universal Video Decoder(UVD)
Output Connectors	1 x Dual-Link DVI-D, 1x DisplayPort™; 1x HDMI

Supported Display Resolutions and Refresh Rates

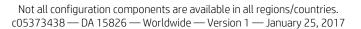
Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rate*	DVI-D	DisplayPort™	HDMI	Standard
Resolution	Kerresinkate				Standard



Technical Specifications – Graphics

640 x 480	60, 75, 85	x	х	х	VESA DMT, CVT 0.31M3
720 x 400	70	x	X	х	IBM VGA
800 x 600	60, 75, 85	x	X	x	VESA DMT, CVT0.48M3
1024 x 768	60, 75, 85	x	Х	x	VESA DMT, CVT 0.79M3
1152 x 864	60, 75, 85	X	х	x	VESA DMT, CVT 0.83MA
1280 x 720	60, 75, 85	X	х	х	VESA DMT, CVT 0.92M9, CEA-770.3
1280 x 768	60, 60RB, 75, 85	X	Х	х	VESA DMT, CVT 0.98M9/0.98M9-R
1280 x 800	60, 75, 85	x	X	х	VESA DMT
1280 x 960	60, 75, 85	Х	X	х	VESA DMT
1280 x 1024	60, 75, 85	х	Х	х	VESA DMT, CVT 1.31M4
1366 x 768	60, 60RB	X	Х	х	VESA DMT
1440 x 900	60, 60RB	X	Х	х	VESA DMT
1600 x 900	60, 60RB, 75, 85	x	Х	х	VESA DMT
1680 x 1050	60, 60RB, 75	X	Х	Х	VESA DMT, CVT 1.76MA/1.76MA-R
1920 x 1080	60	x	Х	х	VESA DMT, CVT 2.07M9, SMPTE 274M
1920 x 1200	60, 60RB, 75, 85	X	Х	Х	DMT, CVT 2.30MA/2.30MA-R
1600 x 1200	60, 75, 85	Х	Х	Х	VESA DMT, 1.92M3
1920 x 1440	60, 75, 85	Х	Х	х	VESA DMT, CVT 2.76M3
2048 x 1536	60, 75	Х	Х	Х	CVT 3.15M3
2560 x 1440	59.951	Х	Х	Х	CVT 3.69M9-R
2560 x 1600	60, 60 RB	Х	Х	х	VESA DMT, CVT 4.10MA/4.10MA-R
3840 x 2160	24		Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	25		Х	х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	30	Х	Х	х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	50		Х	х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	60		Х	х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
4096 x 2160	24		Х	х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	25		Х	х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	30		Х	х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	50		Х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M





Technical Specifications – Graphics

4096 x 2160	60		Х	х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
1920 x 1080	60	Х	Х	х	VESA (SMPTE 274M)
1920 x 1080	50	Х	Х	х	SMPTE 274M
1920 x 1080	30	Х	Х	Х	SMPTE 274M
1920 x 1080	24	Х	Х	х	SMPTE 274M
1280 x 720	60	Х	Х	х	VESA (CEA-770.3)
1280 x 720	50	Х	Х	х	SMPTE 296M
720 x 480	60	Х	Х	Х	MHL (CEA-770.2)

NVIDIA® GeForce® GT 730 1GB PCIe x8 HDMI Graphics Card

Memory	1GB GDDR5 64-bit wide frame buffer operating at 2.5GHz.
Controller Clock Speed	NVIDIA® Kepler™ GPU operating at 901 MHz
Multi-display Support	A maximum of 2 displays are supported by the card
Graphics /API support	Supports Microsoft DirectX 12, OpenGL 4.4 and OpenCL 2 API, Shade Model 5 and DirectCompute 11
Output Connectors	1 x Dual-Link DVI-I; 1x HDMI; Includes DVI to VGA adapter

Supported Display Resolutions and Refresh Rates

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rate*	VGA (DVI-VGA adanter)	DVI-D	HDMI	Standard
640 x 480	60, 75, 85	х	Х	Х	VESA DMT, CVT 0.31M3
720 x 400	70	Х	Х	Х	IBM VGA
800 × 600	60, 75, 85	Х	Х	Х	VESA DMT, CVT0.48M3
1024 x 768	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.79M3
1152 x 864	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.83MA
1280 x 720	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.92M9, CEA-770.3
1280 x 768	60, 60RB, 75, 85	Х	Х	Х	VESA DMT, CVT 0.98M9/0.98M9-R
1280 x 800	60, 75, 85	Х	Х	Х	VESA DMT
1280 x 960	60, 75, 85	Х	Х	Х	VESA DMT
1280 x 1024	60, 75, 85	Х	Х	Х	VESA DMT, CVT 1.31M4

Technical Specifications – Graphics

1366 x 768	60, 60RB	Х	Х	х	VESA DMT
1440 x 900	60, 60RB	Х	Х	Х	VESA DMT
1600 x 900	60, 60RB, 75, 85	Х	Х	Х	VESA DMT
1680 x 1050	60, 60RB, 75	Х	Х	Х	VESA DMT, CVT 1.76MA/1.76MA-R
1920 x 1080	60	Х	Х	Х	VESA DMT, CVT 2.07M9, SMPTE 274M
1920 x 1200	60, 60RB, 75, 85	Х	Х	х	DMT, CVT 2.30MA/2.30MA-R
1600 x 1200	60, 75, 85	Х	Х	Х	VESA DMT, 1.92M3
1920 x 1440	60, 75, 85	Х	Х	Х	VESA DMT, CVT 2.76M3
2048 x 1536	60,75	Х	Х	Х	CVT 3.15M3
2560 x 1440	59.951		Х	Х	CVT 3.69M9-R
2560 x 1600	60, 60RB		Х	х	VESA DMT, CVT 4.10MA/4.10MA-R
3840 x 2160	24			Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	25			Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	30		Х	х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	50				CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	60				CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
4096 x 2160	24			х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	25			х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	30			х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	50				CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	60				CVT-RBv1/v2 (8.85M-R), SMPTE 274M
1920 x 1080	60		Х	Х	VESA (SMPTE 274M)
1920 x 1080	50		х	х	SMPTE 274M
1920 x 1080	30		Х	х	SMPTE 274M
1920 x 1080	24		х	х	SMPTE 274M
1280 x 720	60		х	х	VESA (CEA-770.3)
1280 x 720	50		Х	х	SMPTE 296M
720 x 480	60		х	х	MHL (CEA-770.2)

* >60 refresh rates only for analog (VGA) signaling

NVIDIA® GeForce® GT 730 2GB DP PCIe x8 Graphics Card

Introduction

Get impressive graphics and high resolution dual-display performance in a low profile, PCI Express x8 graphics add-in card based on the NVIDIA[®] Kepler[™] Graphics Processor. Improve your everyday PC, Web conferencing, and video or photo editing.



Technical Specifications – Graphics

Memory	Memory 2GB GD		DR5 64-b	it wide fr	ame buffe	er operating at 900 MHz	
Controller Clock Speed		NVIDIA® Kepler™ GPU operating at 902 MHz					
Multi-display Su	pport	A maxiı	mum of 4	displays	are suppo	orted by the card.	
Graphics /API sup	oport	Supports Microsoft DirectX 12, OpenGL 4.4 and OpenCL 2 APIs, Shade Model 5, UVD 4.2, VCE 2.0, and DirectCompute 11					
Output Connecto	Output Connectors		1 x Dual-Link DVI-I, 1x DisplayPort™; Includes DVI to VGA adapter Display Port output is multi-mode capable, support Audio, HBR2 and MST				
Resolution	Refresh	Rate*	VGA (DVI-VGA adanter)	DVI-D	DisplayPort™	Standard	
640 x 480	60, 75	, 85	Х	Х	Х	VESA DMT, CVT 0.31M3	
720 x 400	70		Х	Х	Х	IBM VGA	
800 x 600	60, 75, 85		Х	Х	Х	VESA DMT, CVT0.48M3	
1024 x 768	60, 75, 85		Х	Х	Х	VESA DMT, CVT 0.79M3	
1152 x 864	60, 75, 85		Х	Х	Х	VESA DMT, CVT 0.83MA	
1280 x 720	60, 75, 85		Х	Х	Х	VESA DMT, CVT 0.92M9, CEA-770.3	
1280 x 768	60, 60RB, 75, 85		Х	Х	Х	VESA DMT, CVT 0.98M9/0.98M9-R	
1280 x 800	60, 75, 85		Х	Х	Х	VESA DMT	
1280 x 960	60, 75, 85		Х	Х	Х	VESA DMT	
1280 x 1024	60, 75, 85		Х	Х	Х	VESA DMT, CVT 1.31M4	
1366 x 768	60, 60RB		Х	Х	Х	VESA DMT	
1440 x 900	60, 60RB		Х	Х	Х	VESA DMT	
1600 x 900	60, 60RB, 75, 85		Х	Х	Х	VESA DMT	
1680 x 1050	60, 60RB, 75		Х	Х	Х	VESA DMT, CVT 1.76MA/1.76MA-R	
1920 x 1080	60		Х	Х	Х	VESA DMT, CVT 2.07M9, SMPTE 274M	
1920 x 1200	60, 60RB, 75, 85		Х	Х	Х	DMT, CVT 2.30MA/2.30MA-R	
1600 x 1200	60, 75	, 85	Х	Х	Х	VESA DMT, 1.92M3	
1920 x 1440	60, 75	, 85	Х	Х	Х	VESA DMT, CVT 2.76M3	
2048 x 1536	60,75		Х	Х	Х	CVT 3.15M3	
2560 x 1440	59.9	51		Х	Х	CVT 3.69M9-R	



Technical Specifications – Graphics

2560 x 1600	60, 60RB	х	х	VESA DMT, CVT 4.10MA/4.10MA-R
3840 x 2160	24		х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	25		х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	30	Х	х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	60		х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
4096 x 2160	24		х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	25		х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	30		х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	60		х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
1920 x 1080	60	Х	х	VESA (SMPTE 274M)
1920 x 1080	50	Х	х	SMPTE 274M
1920 x 1080	30	Х	х	SMPTE 274M
1920 x 1080	24	Х	х	SMPTE 274M
1280 x 720	60	Х	х	VESA (CEA-770.3)
1280 x 720	50	Х	х	SMPTE 296M
720 x 480	60	Х	х	MHL (CEA-770.2)
720 x 576	50	Х	х	ITU-R BT.1358
640 x 480	60	х	х	CEA (VESA DMT)

HARD DISK AND SOLID STATE STORAGE

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

HP 1 TB 7.2K SATA 6.0Gb/s 2.5" Hard Disk Drive				
Capacity	1,000,204,886,016 byte	1,000,204,886,016 bytes		
Rotational Speed	7,200 rpm			
Interface	SATA 6 Gb/s			
Buffer Size	32 MB			
Logical Blocks	1,953,525,168			
	Single Track:	2.0 ms		
Seek Time (typical reads, includes controller overhead, includes controller overhead,	Average:	12 ms		
including settling)	Full-Stroke:	25 ms		
Height (nominal)	0.374 in/9.5 mm	0.374 in/9.5 mm		
	Media diameter: 2.5 in/63.5 mm			
Width (nominal)	Physical size: 2.75 in/70 mm			
Operating Temperature	41° to 131° F (5° to 55° C)			

HP 500 GB 7.2K SATA 6.0Gb/s 2.5" Hard Disk Drive*				
Capacity	500,107,862,016 bytes			
Rotational Speed	7,200 rpm			
Interface	SATA 6 Gb/s			
Buffer Size	16 MB			
Logical Blocks	976,773,168			
Seek Time (typical reads,	Single Track:	2.0 ms		
includes controller overhead, including settling)	Average:	12 ms		



Technical Specifications – Hard Disk and Solid State Storage

	Full-Stroke:	25 ms		
Height (nominal)	0.267 in/6.8 mm	0.267 in/6.8 mm		
Width (nominal)	Media diameter: 2.5 in/63.5 mm			
width (normal)	Physical size: 2.75 in/70 mm			
Operating Temperature	41° to 131° F (5° to 55° C)			
*NOTE: For hard drives and solid state drives. GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to				

*NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

Formatted Capacity	500,107,862,016 b	ytes		
Spindle Speed	7,200 rpm			
Interface	Serial ATA 3.0 (6.0	Gb/s)		
Buffer Size	16 MB			
Logical Blocks	976,773,168			
	Single Track:	2.0 ms		
Seek Time (average)	Average:	11 ms		
	Full-Stroke:	21 ms		
Height (nominal)	1 in/2.54 cm	1 in/2.54 cm		
	Media diameter: 3.	5 in/8.89 cm		
Width (nominal)	Physical size: 4 in/10.2 cm			
Operating Temperature	41° to 131° F (5° to 55° C)			

GB (for Windows 10) of system disk is reserved for the system recovery software.

HP 1 TB* 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive*			
Formatted Capacity	1,000,204,886,016 bytes		
Rotational Speed	7,200 rpm		
Interface	Serial ATA 3.0 (6.0 Gb/s)		
Buffer Size	32 MB		



Technical Specifications – Hard Disk and Solid State Storage

Logical Blocks	1,953,525,168			
	Single Track:	2.0 ms		
Seek Time (average)	Average:	11 ms		
	Full-Stroke:	21 ms		
Height (nominal)	1 in/2.54 cm			
	Media diameter: 3.5 in/8.89 cm			
Width (nominal)	Physical size: 4 in/10.2 cm			
Operating Temperature	41° to 131° F (5° to 55° C)			
* For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB				

(for Windows 10) of system disk is reserved for the system recovery software.

HP 2 TB* 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive*				
Formatted Capacity	2 TB			
Rotational Speed	7,200 rpm			
Interface	SATA 6Gb/s NCQ			
Cache, Multisegmented (MB)	64 MB			
	Read	<8.5 ms		
Seek Time (average)	Write	<9.5 ms		
Height	1.028 in/26.11 mm			
Width	4.0 in/101.6 mm			
Depth	5.787 in/146.99 mm			
Weight	1.38 lb/626 g			
Operating Temperature	32° to 140° F (0° to 60° C)			
*NOTE: For hard drive	s and solid state drives, GB = 1	I billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16		

HP 1 TB* SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)*				
Formatted Capacity	1 TB			
Spindle Speed	5,400 rpm +/- 0.2%			
Drive Type	Solid State Hybrid Drive (SSHD) technology with NAND Flash			



SATA 6 Gb/s				
64 MB	64 MB			
8 GB				
976,773,168	976,773,168			
Single Track:	2.	0 ms		
Average:	12	2 ms		
0.374 +/008 in (9.5 +/- 0	0.374 +/008 in (9.5 +/- 0.2 mm)			
2.750 +/- 0.010 in (69.85 +/- 0.25 mm)				
3.951 +0.008 / -0.010 in (3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)			
0.254 lb/115 g (max)				
32° to 140° F (0° to 60° C)				
	64 MB 8 GB 976,773,168 Single Track: Average: 0.374 +/008 in (9.5 +/-) 2.750 +/- 0.010 in (69.85) 3.951 +0.008 / -0.010 in 0.254 lb/115 g (max)	64 MB 8 GB 976,773,168 Single Track: 2. Average: 12 0.374 +/008 in (9.5 +/- 0.2 mm) 2.750 +/- 0.010 in (69.85 +/- 0.2 mm) 3.951 +0.008 / -0.010 in (100.35 +/ 0.254 lb/115 g (max)		

HP 500 GB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)*					
Formatted Capacity	500 GB				
Spindle Speed	5,400 rpm +/- 0.2%				
Drive Type	Solid State Hybrid Drive	e (SSHD) technology with NAND Flash			
Interface	SATA 6 Gb/s	SATA 6 Gb/s			
Cache Buffer	64 MB	64 MB			
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB				
Number of Sectors	976,773,168	976,773,168			
	Single Track:	2.0 ms			
Seek Time (typical reads)	Average:	12 ms			
Height	0.268 +/008 in (6.8 +/- 0.2 mm)				
Width	2.750 +/- 0.010 in (69.	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)			
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)				



Weight	0.209 lb/95 g (max) 41° to 131° F (5° to 55° C)	
Operating Temperature		
	state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to (for Windows 8.1/10) of system disk is reserved for the system recovery software.	

HP 1-TB SATA 6G 3.5" 8GB Solid State Hybrid Drive (SSHD)*
•

Formatted Capacity	1 TB	1 TB		
Spindle Speed	7,200 rpm	7,200 rpm		
Drive Type	Solid State Hybrid I	Drive (SSHD) technology with NAND Flash		
Interface	Serial ATA (SATA)			
Cache Buffer	64 MB			
NAND Flash Multilevel Cell (MLC)	8 GB	8 GB		
Number of Sectors	1,953,525,168	1,953,525,168		
 <i>(</i>	Single Track:	2.0 ms		
Seek Time (typical reads)	Average:	11 ms		
Height	0.783 in / 2.01 cm	0.783 in / 2.01 cm		
Width	4 in / 10.2 cm	4 in / 10.2 cm		
Length	5.79 in / 14.7 cm	5.79 in / 14.7 cm		
Weight	0.88 lb/400 g	0.88 lb/400 g		
Operating Temperature	41° to 131° F (5° to	41° to 131° F (5° to 55° C)		

500GB* 2.5" FIPS 140-2 SED Solid State Drive*	
Formatted Capacity 500 GB	
Architecture Self-Encrypting (SED) Solid State Drive with SATA interface.	



Technical Specifications – Hard Disk and Solid State Storage

	1			
Interface	Serial ATA (6.0 Gb/s)			
Form Factor	2.5 inch	2.5 inch		
Height	6.80 mm ± 0.20			
Width	69.85 mm ± 0.25			
Length	100.35 mm ± 0.25/0.20			
Weight (typical)	<95 g (0.209 lb)			
Bandwidth Performance	Sustained data transfer rate OD	100 MB/s max		
	I/O data-transfer rate	600 MB/s max		
Power	Power consumption: Spinup (max): 1.00A Idle, active: 0.70W Sleep 0.18W			
Environmental	Operating Temperature:		32° to 140° F (0° to 60° C)	
(all conditions, non-condensing)	Relative Humidity:		5% to 95%	
	Shock:		Maximum 400 G/2 ms	

256GB* TLC SED SSD 2.5" FIPS Drive*		
Unformatted Capacity	256 GB	
Architecture	Self-Encrypting (SED) Solid State Drive with SATA interface.	
Interface	Serial ATA (6.0 Gb/s)	
Form Factor	5 inch	
Height	7 mm	
Width	69.85 mm	
Length	100.45 mm	



Technical Specifications – Hard Disk and Solid State Storage

Weight (typical)	10 g (0.022 lb) max		
Bandwidth Performance	Sequential read (128KB transfer)	530	
	Sequential write (128KB transfer)	500	
	Random read (4KB transfer)	55,000	
	Random write (4KB transfer)	83,000	
Power	SATA Power consumption	Sleep Typical: 2m	W
		Idle, average: 55n	าพ
		Active, average:	70mW
		Active maximum	(128KB transfer): 3000 mW
Environmental (all conditions, non-condensing)	Operating Temperatu	ıre	32° to 1 58 ° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity		5% to 95%
	Non-operating Shock		1500 G/0.5ms
	Non-operating Vibration		5-800Hz @ 3.10G

512GB* TLC SED SSD 2.5" FIPS Drive*		
Unformatted Capacity	512 GB	
Architecture	Self-Encrypting (SED) Solid State Drive with SATA interface.	
Interface	Serial ATA (6.0 Gb/s)	
Form Factor	2.5 inch	
Height	7 mm	



Width	69.85 mm		
Length	100.45 mm		
Weight (typical)	10 g (0.022 lb) max		
Bandwidth Performance	Sequential read (128KB transfer)	530	
	Sequential write (128KB transfer)	500	
	Random read (4KB transfer)	92,000	
	Random write (4KB transfer)	83,000	
Power	SATA Power Sleep Typical: 2m consumption Idle, average: 55n		าพ
		Active, average: Active maximum	(128KB transfer): 4000 mW
Environmental	Operating Temperature		32° to 1 58 ° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity		5% to 95%
	Non-operating Shock		1500 G/0.5ms
	Non-operating Vibration		5-800Hz @ 3.10G

GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

500 GB* SATA 2.5" Self-Encrypting (SED) Opal 2 Solid State Drive*	
Unformatted Capacity 500GB	
Architecture	Self-Encrypting (SED) Solid State Drive with 25nm MLC NAND Flash and SATA interface



Technical Specifications – Hard Disk and Solid State Storage

Interface	Serial ATA 2.0 (3.0 Gb/s)		
NAND Flash	25nm MLC NAND Flash		
Height	.275 in/7mm		
Width	2.75 in/69.85 mm		
Length	3.95 in/100.5 mm		
Weight	0.161 lb (73 g)		
Bandwidth Performance	Sustained Sequential 128k Read:	Up to 450 MB/s	
	Sustained Sequential 128k Write:	Up to 260 MB/s	
	Random 4k Read:	Up to 46K IOPs	
	Random 4k Write:	Up to 56K IOPs	
Latency	Read:	55 µs	
	Write:	55 µs	
Power	SATA power consumption:	160 mW (active average); <85 mW (idle average)	
Useful Drive Life	72TB written, up to 40GB/day for 5 years		
	Operating Temperature:	32° to 158° F (0° to 70° C)	
Environmental (all conditions, non-condensing)	Relative Humidity:	5% to 95%	
	Shock:	1,500 G/1 ms	

GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

256 GB SATA 2.5" TLC SED SSD Opal 2 Drive*

Technical Specifications – Hard Disk and Solid State Storage

Unformatted Capacity	256 GB 500,118,192 (User Addressable Sectors)		
Architecture	Self-Encrypting (SED) Solid State Drive with NAND Flash and SATA interface. Trusted Computing Group (TCG) OPAL 2.0 compliant encrypted solid state drive		
Interface	Serial ATA (6.0 Gb/s)		
Form Factor	2.5 inch		
Height	6.80 mm ± 0.20		
Width	69.85 mm ± 0.25		
Length	100.20 mm ± 0.25		
Typical Weight	37.4 g		
Bandwidth Performance	Sustained Sequential Read: Up to 520 MB/s		
	Sustained Sequential Write:	Up to 460 MB/s	
Power	Power consumption: Active: 3.891W; lo		le: 0.085W
Mean Time Between Failure (MTBF)	1,500,000 hours		
Environmental	Operating Temperature:		32° to 158° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity:		5% to 95%
	Shock:		1,500 G/0.5 ms

GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

512 GB SATA 2.5" TLC SED SSD Opal 2 Drive*			
Unformatted Capacity	rmatted Capacity 512 GB 1,000,215,216 (User Addressable Sectors)		
ArchitectureSelf-Encrypting (SED) Solid State Drive with NAND Flash and SATA interface. Trusted Computing Group (TCG) OPAL 2.0 compliant encrypted solid state drive			
Interface	Serial ATA (6.0 Gb/s)		



Form Factor	2.5 inch		
Height	7 mm ± 0.20		
Width	69.85 mm ± 0.25		
Length	100.20 mm ± 0.25		
Typical Weight	37.4 g		
Bandwidth Performance	Sustained Sequential Read:	d: Up to 515 MB/S	
	Sustained Sequential Write:		
Power	Maximum active power: ≤4 Power consumption: Average power: 70mW Slumber low power mode: 4		0mW
Mean Time Between Failure (MTBF)	Up to 1,750,000 hours		
Environmental	Operating Temperature:		0°C to 70°C (32°F to 158°F)
(all conditions, non-condensing)	Non-operating temperature and storage		-55°C to +85°C (-67°F to 185°F)
	Operating and non-operating shock		1,500 G/0.5 ms

256GB Turbo Drive G2 TLC Solid State Drive		
Unformatted Capacity	256 GB	
Architecture	Solid State Drive with TLC NAND Flash and PCIE interface. Complies with NVMe Standard Power Saving Modes: L1 substates support Multi Queue support	
Interface	PCI-E Gen3 x 4	
Form Factor	M.2 2280	
Height	3.73 mm	



Width	22.00 ± 0.15 mm			
Length	80.00 ± 0.15 mm			
Weight	Up to 8 g			
Bandwidth Performance	Sustained Sequential Read: Up to 2600 MB/s			
	Sustained Sequential Write: Up to 1000 MB/s			
Power	Active: Typical 6.1W; Power consumption: Idle: Typical 80mW L1.2: Typical 5mW		;	
Mean Time Between Failure (MTBF)	1,500,000 hours			
Environmental	Operating Temperature:		32° to 158° F (0° to 70° C)	
(all conditions, non-condensing)	Relative Humidity:		5% to 95%	
	Shock:		1,500 G/0.5 ms	

512GB Turbo Drive G2 TLC Solid State Drive			
Unformatted Capacity	512 GB		
Architecture	Solid State Drive with TLC NAND Flash and PCIE interface. Complies with NVMe Standard		
	Power Saving Modes: L1 substates support Multi Queue support		
Interface	PCI-E Gen3 x 4		
Form Factor	M.2 2280		
Height	3.73 mm		
Width	22.00 ± 0.15 mm		
Length	80.00 ± 0.15 mm		
Weight	Up to 8 g		



Bandwidth Performance	Sustained Sequential Read:	Up to 2600 MB/s	
	Sustained Sequential Write:	Up to 1200 MB/s	
Power	Active: Typical 6.1W; Power consumption: Idle: Typical 80mW L1.2: Typical 5mW		
Mean Time Between Failure (MTBF)	1,500,000 hours		
Environmental	Operating Temperature:		32° to 158° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity:		5% to 95%
	Shock:		1,500 G/0.5 ms

1TB Turbo Drive G2 TLC Solid State Drive					
Unformatted Capacity	1 TB	1 TB			
Architecture	Solid State Drive with TLC NAND Flash and PCIE interface. Complies with NVMe Standard Power Saving Modes: L1 substates support Multi Queue support				
Interface	PCI-E Gen3 x 4				
Form Factor	M.2 2280				
Height	3.73 mm				
Width	22.00 ± 0.15 mm				
Length	80.00 ± 0.15 mm				
Weight	Up to 8 g				
Bandwidth Performance	Sustained Sequential Read: Up to 2600 MB/s				



	Sustained Sequential Write: Up to 1400 MB/s		
Power	Active: Typical 6.1W;Power consumption:Idle: Typical 80mWL1.2: Typical 5mW		;
Mean Time Between Failure (MTBF)	1,500,000 hours		
Environmental (all conditions, non-condensing)	Operating Temperature:		32° to 158° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity:		5% to 95%
	Shock:		1,500 G/0.5 ms

Capacity	1,000,204,886,016 bytes		
Rotational Speed	7,200 rpm		
Interface	SATA 6 Gb/s		
Buffer Size	32 MB		
Logical Blocks	1,953,525,168		
	Single Track:	2.0 ms	
Seek Time (typical reads, includes controller overhead,	Average:	12 ms	
including settling)	Full-Stroke:	25 ms	
Height (nominal)	0.374 in/9.5 mm		
Width (nominal)	Media diameter: 2.5 in/63.5 mm		
	Physical size: 2.75 in/70 mm		
Operating Temperature	41° to 131° F (5° to 55° C)		

36 GB (for Windows 10) of system disk is reserved for the system recovery software.



HP 500 GB 7.2K SATA 6.0	DGb/s 2.5" Hard D)isk Drive*	
Capacity	500,107,862,016 bytes		
Rotational Speed	7,200 rpm		
Interface	SATA 6 Gb/s		
Buffer Size	16 MB		
Logical Blocks	976,773,168		
Seek Time (typical reads, includes controller overhead, including settling)	Single Track:	2.0 ms	
	Average:	12 ms	
	Full-Stroke:	25 ms	
Height (nominal)	0.267 in/6.8 mm		
Width (nominal)	Media diameter: 2.5 in/63.5 mm		
	Physical size: 2.75 in/70 mm		
Operating Temperature	41° to 131° F (5° to 55° C)		

*NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

500GB* 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Formatted Capacity	500,107,862,016 bytes			
Spindle Speed	7,200 rpm			
Interface	Serial ATA 3.0 (6.0 Gb/s)	Serial ATA 3.0 (6.0 Gb/s)		
Buffer Size	16 MB			
Logical Blocks	976,773,168			
Seek Time (average)	Single Track:	2.0 ms		
	Average:	11 ms		
	Full-Stroke:	21 ms		
Height (nominal)	1 in/2.54 cm			
Width (nominal)	Media diameter: 3.5 in/8.89 cm			



Technical Specifications – Hard Disk and Solid State Storage

	Physical size: 4 in/10.2 cm		
Operating Temperature	41° to 131° F (5° to 55° C)		
*NOTE: For hard drives and solid state drives $GB = 1$ hillion bytes $TB = 1$ trillion bytes. Actual formatted capacity is less. Up to 36			

*NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

HP 1 TB* 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive* **Formatted Capacity** 1,000,204,886,016 bytes **Rotational Speed** 7,200 rpm Interface Serial ATA 3.0 (6.0 Gb/s) **Buffer Size** 32 MB **Logical Blocks** 1,953,525,168 Single Track: 2.0 ms Seek Time (average) 11 ms Average: Full-Stroke: 21 ms Height (nominal) 1 in/2.54 cm Media diameter: 3.5 in/8.89 cm Width (nominal) Physical size: 4 in/10.2 cm Operating 41° to 131° F (5° to 55° C) Temperature * For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB

* For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up (for Windows 10) of system disk is reserved for the system recovery software.

HP 2 TB* 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive*		
Formatted Capacity	2 TB	
Rotational Speed	7,200 rpm	
Interface	SATA 6Gb/s NCQ	
Cache, Multisegmented (MB)	64 MB	
	Read <8.5 ms	
Seek Time (average) Write <9.5 ms		<9.5 ms
Height	1.028 in/26.11 mm	
Width	4.0 in/101.6 mm	

Technical Specifications – Hard Disk and Solid State Storage

Depth	5.787 in/146.99 mm
Weight	1.38 lb/626 g
Operating Temperature	32° to 140° F (0° to 60° C)
*NOTE: For hard drives and solid state drives. GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16	

GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

Formatted Capacity	500 GB		
Spindle Speed	5,400 rpm +/- 0.2%		
Drive Type	Solid State Hybrid D	Drive (SSHD) technology with NAND Flash	
Interface	SATA 6 Gb/s		
Cache Buffer	64 MB		
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB		
Number of Sectors	976,773,168		
	Single Track:	2.0 ms	
Seek Time (typical reads)	Average:	12 ms	
Height	0.268 +/008 in (6.8 +/- 0.2 mm)		
Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)		
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)		
Weight	0.209 lb/95 g (max)		
Operating Temperature	41° to 131° F (5° to 55° C)		

16 GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

HP 1 TB* SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)*

Formatted Capacity



Technical Specifications – Hard Disk and Solid State Storage

Spindle Speed	5,400 rpm +/- 0.2%		
Drive Type	Solid State Hybrid Drive (SSHD) technology with NAND Flash		
Interface	SATA 6 Gb/s		
Cache Buffer	64 MB		
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB		
Number of Sectors	976,773,168		
	Single Track:	2.0 ms	
Seek Time (typical reads)	Average:	12 ms	
Height	0.374 +/008 in (9.5 +/- 0.2 mm)		
Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)		
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)		
Weight	0.254 lb/115 g (max)		
Operating Temperature	32° to 140° F (0° to 60° C)		
* For hard drives and solid stat	e drives, GB = 1 billion	bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB	

(for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

HP 1-TB SATA 6G 3.5" 8GB Solid State Hybrid Drive (SSHD)*

Formatted Capacity	1 TB		
Spindle Speed	7,200 rpm		
Drive Type	Solid State Hybrid Drive (SSHD) technology with NAND Flash		
Interface	Serial ATA (SATA)		
Cache Buffer	64 MB		
NAND Flash Multilevel Cell (MLC)	8 GB		
Number of Sectors	1,953,525,168		
	Single Track:	2.0 ms	
Seek Time (typical reads)	Average:	11 ms	
Height	0.783 in / 2.01 cm		
Width	4 in / 10.2 cm		



Length	5.79 in / 14.7 cm	
Weight	0.88 lb/400 g	
Operating Temperature	41° to 131° F (5° to 55° C)	
*NOTE: For bard drives and co	blid state drives $GB = 1$ billion bytes $TB = 1$ trillion bytes Actual formatted capacity is less. Up to	

*NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

Formatted Capacity	500 GB		
Architecture	Self-Encrypting (SED) Solid State Drive with SATA interface.		
Interface	Serial ATA (6.0 Gb/s)		
Form Factor	2.5 inch		
Height	6.80 mm ± 0.20		
Width	69.85 mm ± 0.25		
Length	100.35 mm ± 0.25/0.20		
Weight (typical)	<95 g (0.209 lb)		
Bandwidth Performance	Sustained data transfer rate OD	100 MB/s max	
	I/O data-transfer rate	600 MB/s max	
Power	Power consumption:	Spinup (max): 1.00A Idle, active: 0.70W Sleep 0.18W	
Environmental	Operating Temperature:		32° to 140° F (0° to 60° C)
(all conditions, non-condensing)	Relative Humidity:		5% to 95%
	Shock:		Maximum 400 G/2 ms

GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.



2300D" ILL SEV 33V 2.3			
Unformatted Capacity	256 GB		
Architecture	Self-Encrypting (SED) Solid State Drive with SATA interface.		
Interface	Serial ATA (6.0 Gb/s)		
Form Factor	2.5 inch		
Height	7 mm		
Width	69.85 mm		
Length	100.45 mm		
Weight (typical)	10 g (0.022 lb) max		
Bandwidth Performance	Sequential read (128KB transfer)	530	
	Sequential write (128KB transfer)	500	
	Random read (4KB transfer)	55,000	
	Random write (4KB transfer)	83,000	
Power	SATA Power consumption Active, average: 55n Active maximum		nW
Environmental (all conditions, non-condensing)	Operating Temperature		32° to 1 58 ° F (0° to 70° C)
(מוג נטווטונוטוזא, ווטוו-נטווטפוזאווזאַ)	Relative Humidity		5% to 95%
	Non-operating Shock		1500 G/0.5ms
	Non-operating Vibration		5-800Hz @ 3.10G



512GB* TLC SED SSD 2.5" FIPS Drive*				
Unformatted Capacity	512 GB			
Architecture	Self-Encrypting (SED) Sol	id State Drive with SA	TA interface.	
Interface	Serial ATA (6.0 Gb/s)			
Form Factor	2.5 inch			
Height	7 mm			
Width	69.85 mm			
Length	100.45 mm			
Weight (typical)	10 g (0.022 lb) max	10 g (0.022 lb) max		
Bandwidth Performance	Sequential read (128KB transfer)	530		
	Sequential write (128KB transfer)	500		
	Random read (4KB transfer)	92,000		
	Random write (4KB transfer)	83,000		
Power	SATA Power consumption	Sleep Typical: 2mw Idle, average: 55mw Active, average: 70mW Active maximum (128KB transfer): 4000 mW		
	Operating Temperature 32° to 158° F (0° to 70° C)		32° to 1 58 ° F (0° to 70° C)	



Environmental	Relative Humidity	5% to 95%	
(all conditions, non-condensing)	Non-operating Shock	1500 G/0.5ms	
	Non-operating Vibration	5-800Hz @ 3.10G	
*NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16			

GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

500 GB* SATA 2.5" Self-Encrypting (SED) Opal 2 Solid State Drive*				
Unformatted Capacity	500GB			
Architecture	Self-Encrypting (SED) Solid Sta	ate Drive with 25nm MLC NAND Flash and SATA interface		
Interface	Serial ATA 2.0 (3.0 Gb/s)			
NAND Flash	25nm MLC NAND Flash			
Height	.275 in/7mm			
Width	2.75 in/69.85 mm	2.75 in/69.85 mm		
Length	3.95 in/100.5 mm			
Weight	0.161 lb (73 g)			
Bandwidth Performance	Sustained Sequential 128k Read:	Up to 450 MB/s		
	Sustained Sequential 128k Write:	Up to 260 MB/s		
	Random 4k Read:	Up to 46K IOPs		
	Random 4k Write: Up to 56K IOPs			
Latency	Read:	55 μs		
	Write:	55 μs		
Power	SATA power consumption:	160 mW (active average); <85 mW (idle average)		



Technical Specifications – Hard Disk and Solid State Storage

Useful Drive Life	72TB written, up to 40GB/day for 5 years		
	Operating Temperature: 32° to 158° F (0° to 70° C)		
Environmental (all conditions, non-condensing)	Relative Humidity: 5% to 95%		
	Shock:	1,500 G/1 ms	

*NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

256 GB SATA 2.5" TLC SED SSD Opal 2 Drive*

	1			
Unformatted Capacity	256 GB 500,118,192 (User Addressable Sectors)			
Architecture	Self-Encrypting (SED) Solid State Drive with NAND Flash and SATA interface. Trusted Computing Group(TCG) OPAL compliant encrypted solid state drive			
Interface	Serial ATA (6.0 Gb/s)			
Form Factor	2.5 inch			
Height	6.80 mm ± 0.20			
Width	69.85 mm ± 0.25	69.85 mm ± 0.25		
Length	100.20 mm ± 0.25			
Weight	Up to 73 g			
Bandwidth Performance	Sustained Sequential Read:	ed Sequential Up to 520 MB/s		
	Sustained Sequential Write:			
Power	Power consumption: Active: 3.891W; Idle: 0.085W			
Mean Time Between Failure (MTBF)	1,500,000 hours			
Environmental (all conditions, non-condensing)	Operating Temperature:		32° to 158° F (0° to 70° C)	
(an conditions, non-condensing)	Relative Humidity:		5% to 95%	

Shock:	1,500 G/0.5 ms
ate drives, GB = 1 billion bytes. TB = 1 trillion byt Windows 8.1/10) of system disk is reserved for tl	

256GB Turbo Drive G2 TLC OPAL2.0 SED Solid State Drive				
Unformatted Capacity	256 GB			
Architecture	Solid State Drive with TLC NAND Flash and PCIE interface. Complies with NVMe Standard Power Saving Modes: L1 substates support Multi Queue support TCG OPAL2.0 compliance			
Interface	PCI-E Gen3 x 4			
Form Factor	M.2 2280	M.2 2280		
Height	3.73 mm			
Width	22.00 ± 0.15 mm			
Length	80.00 ± 0.15 mm			
Weight	Up to 8 g			
Bandwidth Performance	Sustained Sequential Read:	Up to 2200 MB/s		
	Sustained Sequential Write:	ential Up to 1000 MB/s		
Power	Power consumption:	Active: Typical 6.1W; ower consumption: Idle: Typical 40mW L1.2: Typical 5mW		
Mean Time Between Failure (MTBF)	1,500,000 hours			
	Operating Temperature:	:	32° to 158° F (0° to 70° C)	



Environmental	Relative Humidity:	5% to 95%
(all conditions, non-condensing)	Shock:	1,500 G/0.5 ms

512GB Turbo Drive G2 TLC OF	AL2.0 SED Solid Sta	te Drive	
Unformatted Capacity	512 GB		
	Solid State Drive with TI		Einterface.
Architecture	Complies with NVMe Sta Power Saving Modes: L1		
	Multi Queue support		
	TCG OPAL2.0 complianc	e	
Interface	PCI-E Gen3 x 4		
Form Factor	M.2 2280		
Height	3.73 mm		
Width	22.00 ± 0.15 mm		
Length	80.00 ± 0.15 mm		
Weight	Up to 8 g		
Bandwidth Performance	Sustained Sequential Read:	Up to 2200 MB/s	
	Sustained Sequential Write:	Up to 1000 MB/s	
		Active: Typical 6.1W	;
Power	Power consumption:	Idle: Typical 40mW	
	L1.2: Typical 5mW		
Mean Time Between Failure (MTBF)	1,500,000 hours		
Environmental (all conditions, non-condensing)	Operating Temperature	:	32° to 158° F (0° to 70° C)
	Relative Humidity:		5% to 95%



Technical Specifications – Hard Disk and Solid State Storage

Shock:	1,500 G/0.5 ms

Unformatted Capacity	128 GB		
Architecture	TLC NAND Flash		
Interface	SATA 3.2 (6.0 Gb/s)		
Form Factor	2.5 inch		
Dimensions (W x H x D)	6.98 x 0.7 x 10.05 cm		
Weight	31g		
Bandwidth Performance	Sustained Sequential Read:	Up to 510 MB/s	
	Sustained Sequential Write:	Up to 330 MB/s	
	Random Read:	Up to 38K IOPs	
	Random Write: Up to 70K IOPs		
Power	DC power requirement:	quirement: 5 VDC 5%-100 mV ripple p-p	
	Total power consumption:		
Useful Drive Life	72TB written, up to 40GB/	day for 5 years	
Environmental	Operating Temperature:		32° to 158° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity:		5% to 95%
	Shock:		1,500 G/0.5 ms

NOTE: "For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software."

256GB SATA 2.5" Value (Non-SED) Solid State Drive



Unformatted Capacity	256 GB		
Architecture	TLC NAND Flash		
Interface	SATA 3.2 (6.0 Gb/s)		
Form Factor	2.5 inch		
Dimensions (W x H x D)	6.98 x 0.7 x 10.05 cm		
Weight	31g		
Bandwidth Performance	Sustained Sequential Read:	Up to 510 MB/s	
	Sustained Sequential Write:	Up to 330 MB/s	
	Random Read:Up to 38K IOPsRandom Write:Up to 70K IOPs		
Power	DC power requirement:	5 VDC 5%-100 mV ripple p-p	
	Total power consumption:		
Useful Drive Life	72TB written, up to 40GB/	day for 5 years	
Environmental	Operating Temperature:		32° to 158° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity:		5% to 95%
	Shock:		1,500 G/0.5 ms

256GB SATA 2.5" TLC Solid State Drive		
Formatted Capacity	Formatted Capacity 256 GB	
Architecture	Solid State Drive with SATA interface; ATA 8 Compliant and SATA 2.6 compliant	



Interface	Serial ATA 3 (6.0 Gb/s)			
Form Factor	2.5 inch			
	2.5 11(11			
Height	7 mm ± 0.20			
Width	69.85 mm ± 0.25			
Length	100.2 mm ± 0.25			
Weight (typical)	36.5 g (+2)	36.5 g (+2)		
Data Transfer Rate	Sequential ReadUp to 500 MB/sSequential WriteUp to 455 MB/s			
(128k Sequential)				
Power Watts	Read: 95 mWPower consumption (avg):Write: 95 mWStandby: 70 mWDEVSLP: <7 mW			
Environmental	Operating Temperature:		32° to 158° F (0° to 70° C)	
(all conditions, non-condensing)	Relative Humidity:		5% to 95%	
	Shock (2 m Sec half-sine)	:	1500 G peak 0.5ms (operating)	

512 GB SATA 2.5" TLC Solid State Drive*		
Formatted Capacity	512 GB	
Architecture	Solid State Drive with SATA interface; ATA 8 Compliant and SATA 2.6 compliant	
Interface	Serial ATA 3 (6.0 Gb/s)	
Form Factor	2.5 inch	
Height	7 mm ± 0.20	
Width	69.85 mm ± 0.25	
Length	100.2 mm ± 0.25	
Weight (typical)	36.5 g (+2)	



Data Transfer Rate (128k Sequential)	Sequential Read	Up to 500 MB/s	
	Sequential Write	Up to 455 MB/s	
Power Watts	Power consumption (avg):	Read: 95 mW Write: 95 mW Standby: 70 mW DEVSLP: <7 mW	
Environmental	Operating Temperature:	'	32° to 158° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity:		5% to 95%
	Shock (2 m Sec half-sine):		1500 G peak 0.5ms (operating)



Technical Specifications – Optical Drives

OPTICAL DRIVES

HP 9.5mm G3 800/600 HP 9.5mm G3 800/600		T DVD-Writer
Height	12.7mm height	
Orientation	Either horizontal or vertical	
Interface type	SATA/ATAPI	
Disc recording capacity	Up to 8.5 GB DL or 4.7 GB star	ıdard
Dimensions (W × H × D)	5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel	
Weight (max)	0.42 lb (190 g)	
	DVD-R DL	Up to 6X
	DVD+R	Up to 8X
	DVD+RW	Up to 8X
	DVD+R DL	Up to 6X
Write speeds	DVD-R	Up to 8X
	DVD-RW	Up to 6X
	CD-R	Up to 24X
	CD-RW	Up to 24X
	DVD-RW, DVD+RW	Up to 8X
	DVD-R DL, DVD+R DL	Up to 8X
	DVD+R, DVD-R	Up to 8X
Read speeds	DVD-ROM DL, DVD-ROM	Up to 8X
	CD-ROM, CD-R	Up to 24X
	CD-RW	Up to 24X
	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)
Accord time	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)
Access time (typical reads, including settling)	Stop Time	6 seconds (typical)
	Source	Slimline SATA DC power receptacle
Power	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p
	DC Current	5 VDC (< 1000 mA typical, 1600 mA maximum)
	Temperature	41° to 122° F (5° to 50° C)
	Relative Humidity	10% to 80%
Environmental conditions (operating - non-condensing)	Maximum Wet Bulb Temperature	84° F (29° C)



Technical Specifications – Optical Drives

HP 9.5mm G3 800/600 HP 9.5mm G3 800/600		1T DVD-ROM
Height	12.7mm	
Orientation	Either horizontal or vertical	
Interface type	SATA/ATAPI	
Dimensions (W x H x D)	5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel	
Weight (max)	Up to 0.37 lb (170 g) without bezel	
Read speeds	DVD+R/-R/+RW/ -RW/+R DL /-R DL	Up to 8X
	DVD-ROM	Up to 8X
	CD-ROM, CD-R	Up to 24X
	CD-RW	Up to 24X
Access time	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)
(typical reads, including settling)	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)
Power	Source	Slimline SATA DC power receptacle
	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p
	DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum
Environmental (all conditions non-condensing)	Temperature	41° to 122° F (5° to 50° C)
	Relative Humidity	10% to 80%
	Maximum Wet Bulb Temperature (operating)	84° F (29° C)



Technical Specifications – Memory

SYSTEM MEMORY SUPPORT

The HP ProDesk 600 G3 Business PC supports the 6th & 7th generation Intel[®] Core[™] processor family. Based on a new PC microarchitecture, the processor is designed for a two-chip platform consisting of a processor and Platform Controller Hub (PCH). The 6th generation Intel[®] Core[™] processor includes an Integrated Memory Controller (IMC). The IMC supports DDR4protocols with two independent, 64-bit wide channels each accessing one or two DIMMs.

- Two channels of non-ECC DDR4 unbuffered dual in-line memory modules (UDIMM) or DDR4 unbuffered small outline dual in-line memory modules (SO-DIMM) with a maximum of two DIMMs per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- Memory data transfer rates of up to 2400MT/s; actual supported data transfer rate determined by the configured processor.
- 64-bit wide channels
- DDR4 system memory I/O voltage of 1.25V
- Theoretical maximum memory bandwidth of:
 - 34 GB/s in dual-channel mode assuming 2400 MT/s

PLATFORM MEMORY SUPPORT

- The Small Form Factor (SFF) and Microtower (MT) platforms support up to four (4) industry-standard DDR4-SDRAM DIMMs.
- The Desktop Mini (DM) supports up to two (2) industry-standard DDR4-SDRAM SO-DIMMs.

CAUTION: You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.



Technical Specifications – Networking and Communications

NETWORKING AND COMMUNICATIONS

Intel® I219LM Gigabit N	Network Connection LOM (standard)	
Connector	RJ-45	
System Interface	PCIe + SMBus	
Controller	Intel® I219LM Gigabit Ethernet Controller	
Data rates supported	Supports operation at 10/100/1000 Mb/s data rates	
IEEE Compliance	IEEE 802.3 Ethernet interface for 1000BASE-T, 100BASETX, and 10BASET applications (802.3ab, 802.3u, and 802.3i, respectively). EEE 802.3az support [Low Power Idle (LPI) mode] IEEE 802.3u auto-negotiation conformance	
Performance	Jumbo Frames (up to 9 kB) 802.1Q & 802.1p Receive Side Scaling (RSS) Two Queues (Tx & Rx)	
Power	 Ultra Low Power at cable disconnect (<1 mW) enables platform support for connected standby Reduced power consumption during normal operation and power down modes Integrated Intel® Auto Connect Battery Saver (ACBS) Single-pin LAN Disable for easier BIOS implementation Fully integrated Switching Voltage Regulator (iSVR) Low Power Link-Up (LPLU) 	
MAC/PHY Interconnect	 PCIe-based interface for active state operation (S0 state) SMBus-based interface for host and management traffic (Sx low power state) 	
Management Interface	MDC/MDIO management interface	
Security & Manageability	Intel [®] vPro [™] support with appropriate Intel chipset components	

Intel® Ethernet I210-T1 Gigabit Network Adapter		
Connector	RJ-45	
System Interface	PCI Express x1	
Controller	Intel® I210 Gigabit Ethernet Controller	
Memory	Integrated Dual 48K configurable transmit receive FIFO Buffers	
Data rates supported	10/100/1000 Mbps	



Technical Specifications – Networking and Communications

IEEE Compliance	802.1P 802.1Q 802.2 802.3 802.3AB 802.3u 802.3u 802.3u	
Bus architecture	PCI-E 2.1	
Data path width	X1, 250 MB/s, Bi-directional interface	
Data transfer mode	Bus-master DMA	
Hardware certifications	FCC, B, CE, TUV-c, TUVus Mark Canada and United States, TUV-GS Mark for European Union	
Power requirement	Aux 3.3 V, 3.0 Watts in 1000 base-T and 1.0 Watts in 100 Base-T	
Boot ROM support	Yes 10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps	
	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps	
Network transfer rate	100BASE-TX (half-duplex) 100 M	bps
	100BASE-TX (full-duplex) 200 MI	ops
	1000BASE-T (full-duplex) 2000 N	Ibps (actual rate limited by PCI bus)
Environmental	Operating Temperature:	32° to 132° F (0° to 55° C)
	Operating Humidity:	85% at 131° F (55° C)
Management	WOL, PXE, DMI, WFM 2.0	

Intel® 8265 802.11ac 2x2 WiFi + Bluetooth® M.2 Combo Card* (802.11AC Wave 2 supported)	
Wireless LAN Standards	IEEE 802.11a
	IEEE 802.11b
	IEEE 802.11g
	IEEE 802.11n
	IEEE 802.11ac
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n
	• 2.402 – 2.482 GHz
	Note:
	The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting



	must fully comply with requirements of 15.247 or otherwise
	disable those channels.
	802.11a/n
	• 4.9 – 4.95 GHz (Japan)
	• 5.15 – 5.25 GHz
	• 5.25 – 5.35 GHz
	• 5.47 – 5.725 GHz
	• 5.825 – 5.850 GHz
	Note: Indonesia no support this band)
Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps
	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
	 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz,
	and 80MHz)
Modulation	Direct Sequence Spread Spectrum
	BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security ¹	IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g
	mode only
	AES-CCMP: 128 bit in hardware
	802.1x authentication
	WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
	WPA2 certification
	 IEEE 802.11i
	 Cisco Certified Extensions, all versions through CCX4 and CCX
	Lite
	WAPI
Network Architecture	Ad-hoc (Peer to Peer)
Models	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power ²	• 802.11b : +16dBm minimum
•	• 802.11g : +14dBm minimum
	• 802.11a : +14dBm minimum
	• 802.11n HT20(2.4GHz) : +14dBm minimum
	 802.11n HT40(2.4GHz) : +12dBm minimum
	 802.11n HT20(5GHz) : +14dBm minimum
	 802.11n HT40(5GHz) : +12dBm minimum
Power Consumption	Transmit: 2.0 W (max)
· · · · · · · · · · · · · · · · · · ·	Receive: 1.6 W (max)
	Idle mode (PSP): 180 mW (WLAN Associated)
	Idle mode: 50 mW (WLAN unassociated)
	Connect Standby: 10 mW (WLAN+BT)
	Radio disabled: 30 mW
Power Management	ACPI and PCI Express compliant power management
_	802.11 compliant power saving mode
Receiver Sensitivity ³	802.11b, 1Mbps : -94dBm maximum
-	802.11b, 11Mbps : -86dBm maximum
	802.11g, 6Mbps : -88dBm maximum
	802.11g, 54Mbps : -74dBm maximum
	802.11a, 6Mbps : -88dBm maximum
	802.11a, 54Mbps : -74dBm maximum
	802.11n, MCS07 : -69dBm maximum
	802.11n, MCS15 : -66dBm maximum
	802.11ac, 1SS, MCS-0 : -86dBm maximum



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Bluetooth [®] Software Supported	Full support of Blue	etooth [®] Security	Provisions		
Electrical Interface	Point to Point, Mult	-	-		
Link Topology					
Bluetooth [®] Software Supported	Microsoft Windows	Bluetooth [®] Soft	ware		
Electrical Interface	USB 2.0 compliant				
Range	Legacy Up to 33 ft (BLE Up to 99 ft (30				
	Peak (Rx) 230 mW Selective Suspend				
Power Consumption	Peak (Tx) 330 mW		1		
	8DPSK	-80 dBm	-70 dBm	-	
	π/4-DQPSK	-80 dBm	-70 dBm		
Receiver Sensitivity	Modulation GFSK	0.01% BER -80 dBm	0.001% BER -70 dBm		
Basaiyar Canaitivity.			wer of +4 dBm for BR a	ana EDK.	
Transmit Power			erate as a Class II Blue		
-	voice channels				
	BLE : 1 Mbps data r Legacy : Synchrono			4 kbps.	
Data Rates and Throughput			· · · ·		
	BLE : 0~39 (2 MHz/	LE : 0~39 (2 MHz/CH) egacy : 3 Mbps data rate; throughput up to 2.17 Mbps			
Number of Available Channels	Legacy : 0~79 (1 MI	Hz/CH)			
Frequency Band	2402 to 2480 MHz				
Bluetooth [®] Specification	4.0/4.1/4.2 Compli				
HP Integrated Module with Blueto			1		
	nay vary by country according to local regulations. asured at a packet error rate of 8% for 802.11b (CKK modulation) and a for 802.11a/g (OFDM modulation).				
1. Check latest software/driv					
LED Activity	LED Amber – Radi	o OFF; LED White	– Radio ON		
	Non-operating	0 to 50,000 ft (15,240 m)		
Altitude	Operating	0 to 10,000 ft (2		
Humidity	Operating Non-operating	10% to 90% (no 5% to 95% (no	on-condensing) n-condensing)		
	Non-operating	-40° to 176° F			
Temperature	Operating	14° to 158° F (-			
Operating Voltage	3.3v +/- 9%				
	Type 1630 : 2g				
Weight	Type 2230 : 2.8g Or				
Waiaba	Type 1630 : 2.3 x	16.0 x 30.0 mm			
	Or				
Dimensions	Type 2230 : 2.3 x 2				
			-Express M.2 MiniCard		
	card to support W communications	LAN MIMO comm	unications and Bluetoo	oth®	
	Two embedded dual band 2.4/5 GHz antennas are provided to card to support WLAN MIMO communications and Bluetooth®				
	display enclosure				
Antenna type			Il diversity, mounted in	the	
	802.11ac, 2SS, MC 802.11ac, 2SS, MC				
	802.11ac, 1SS, MCS-9 : -61dBm maximum 802.11ac, 2SS, MCS-0 : -83dBm maximum				

Security			
Power Management	Microsoft Windows ACPI, and USB Bus Support Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff All necessary regulatory approvals for supported countries, including:		
Power Management Certifications			
Security			
Certifications Bluetooth [®] Profiles Supported	FCC (47 CFR) Part 15C, Section 15.247 & 15.249		
Power Management	ETS 300 328, ETS 300 826		
Certifications	Low Voltage Directive IEC950		
	UL, CSA, and CE Mark		
Certifications Bluetooth® Profiles Supported	UL, CSA, and CE Mark Serial Port Profile (SPP)1.2 Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN)1,1 Generic Object Exchange Profile (GOEP)1,2 Object Push Profile (OPP)1,2 Hard Copy Cable Replacement (HCRP)1,2 Personal Area Networking Profile (PAN)1.0 Human Interface Device Profile (HID)1.0 Hands Free Profile (HFP) 1.5/1.6 Advanced Audio Distribution Profile (A2DP) 1.3 Audio Video Remote Control Profile (AVRCP) 1.3/1.4		
Bluetooth [®] V4.1/V4.2 support feature	V4.1: ESR5/6/7 compliant V4.2: ESR8 compliant, LE Secure Connection – Basic		

*Wireless access point and internet access required. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

Intel® 7265 802.11ac 2x2 DualBand Combo PCIe x1 Card				
Wireles	s LAN Standards	IEEE 802.11a		
		IEEE 802.11b		
		IEEE 802.11g		
		IEEE 802.11n		
		IEEE 802.11ac		
Interop	erability	Wi-Fi certified		
Frequer	ncy Band	802.11b/g/n		
		• 2.402 – 2.482 GHz		
		Note:		
		The FCC has declared as of January 1, 2015 products that utilize		
		passive scanning on channel 12/13 and are capable of		
		transmitting must fully comply with requirements of 15.247 or		
		otherwise disable those channels.		
		802.11a/n		
		• 4.9 – 4.95 GHz (Japan)		
		• 5.15 – 5.25 GHz		
		• 5.25 – 5.35 GHz		
		• 5.47 – 5.725 GHz		
		• 5.825 – 5.850 GHz		
		Note: Indonesia no support this band)		
Data Ra	tes	• 802.11b: 1, 2, 5.5, 11 Mbps		



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	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
	 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)
Modulation	Direct Sequence Spread Spectrum
	BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security ¹	IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g
	mode only
	AES-CCMP: 128 bit in hardware
	802.1x authentication
	WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
	WPA2 certification
	• IEEE 802.11i
	 Cisco Certified Extensions, all versions through CCX4 and CCX
	Lite
	WAPI
Network Architecture	Ad-hoc (Peer to Peer)
Models	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power ²	802.11b : +16dBm minimum
output Fower	
	• 802.11g : +14dBm minimum
	• 802.11a : +14dBm minimum
	• 802.11n HT20(2.4GHz) : +13dBm minimum
	• 802.11n HT40(2.4GHz) : +13dBm minimum
	 802.11n HT20(5GHz) : +12dBm minimum
	 802.11n HT40(5GHz) : +12dBm minimum
	 802.11ac 80MHz(5GHz) : +11dBm minimum
Power Consumption	Transmit: 2.0 W (max)
	Receive: 1.6 W (max)
	Idle mode (PSP): 180 mW (WLAN Associated)
	Idle mode: 60 mW (WLAN unassociated)
	Radio disabled: 30 mW
Power Management	ACPI and PCI Express compliant power management
	802.11 compliant power saving mode
Receiver Sensitivity ³	802.11b, 1Mbps : -94dBm maximum
	802.11b, 11Mbps : -86dBm maximum
	802.11g, 6Mbps : -88dBm maximum
	802.11g, 54Mbps : -74dBm maximum
	802.11a, 6Mbps : -86dBm maximum
	802.11a, 54Mbps : -72dBm maximum
	802.11n, MCS07 : -69dBm maximum 802.11n, MCS15 : -66dBm maximum
	802.11ac, 1SS, MCS-0 : -86dBm maximum
	802.11ac, 1SS, MCS-9 : -61dBm maximum
	802.11ac, 2SS, MCS-0 : -83dBm maximum
Antonna tura	802.11ac, 2SS, MCS-9 : -58dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure
	Two embedded dual band 2.4/5 GHz antennas are provided to the
	card to support WLAN MIMO communications and Bluetooth®
Form Eactor	communications
Form Factor	PCI-Express M.2 MiniCard
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm

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	2			
	Or	1 C O v 20 0 mm		
Weight	Type 1630 : 2.3 x 16.0 x 30.0 mm			
Weight	Type 2230 : 2.8g Or			
	-			
Operating Voltage	Type 1630 : 2g			
Temperature	3.3v +/- 9% Operating 14° to 158° F (–10° to 70° C)			
remperature	Operating Non-operating	–40° to 176° F		
Humidity	Operating		on-condensing)	
numurty	Non-operating	5% to 95% (no	-	
Altitude	Operating	0 to 10,000 ft (
Attitude	Non-operating	0 to 50,000 ft (
LED Activity	LED Amber – Radi			
4. Check latest software/driv				
5. Maximum output power m				
6. Receiver sensitivity is mea				tion) and
a packet error rate of 10%				cion, ana
HP Integrated Module with Blueton				
Bluetooth® Specification	4.2 Compliant			
Frequency Band	2402 to 2480 MHz			
Number of Available Channels	79 (1 MHz) availabl	e channels		
Data Rates and Throughput	3 Mbps data rate; th		2.17 Mbps	
	-			voice
	Synchronous Connection Oriented links up to 3, 64 kbps, voice channels			
	Asynchronous Connection Less links 2178.1 kbps/177.1 kbps			
	asymmetric or 1306.9 kbps symmetric			
	The Bluetooth [®] component shall operate as a Class II Bluetooth [®]			
Transmit Power	The Bluetooth [®] con	nponent shall op	erate as a Class II Blu	etooth®
Transmit Power		• •	erate as a Class II Blu wer of +4 dBm for BR	
Transmit Power Receiver Sensitivity		• •		
	device with a maxin	num transmit po	wer of +4 dBm for BR	
	device with a maxin Modulation	num transmit po	wer of +4 dBm for BR 0.001% BER	
	device with a maxin Modulation GFSK	num transmit po 0.01% BER -80 dBm	wer of +4 dBm for BR 0.001% BER -70 dBm	
	device with a maxin Modulation GFSK π/4-DQPSK	num transmit po 0.01% BER -80 dBm -80 dBm	wer of +4 dBm for BR 0.001% BER -70 dBm -70 dBm	
Receiver Sensitivity	device with a maxin Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW	num transmit po 0.01% BER -80 dBm -80 dBm -80 dBm	wer of +4 dBm for BR 0.001% BER -70 dBm -70 dBm	
Receiver Sensitivity Power Consumption	device with a maxin Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend	num transmit po 0.01% BER -80 dBm -80 dBm -80 dBm	wer of +4 dBm for BR 0.001% BER -70 dBm -70 dBm	
Receiver Sensitivity	device with a maxin Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW	num transmit po 0.01% BER -80 dBm -80 dBm -80 dBm	wer of +4 dBm for BR 0.001% BER -70 dBm -70 dBm	
Receiver Sensitivity Power Consumption	device with a maxin Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend	num transmit po 0.01% BER -80 dBm -80 dBm -80 dBm	wer of +4 dBm for BR 0.001% BER -70 dBm -70 dBm	
Receiver Sensitivity Power Consumption Range Electrical Interface	device with a maxim Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 7 Up to 33 ft (10 m)	num transmit po 0.01% BER -80 dBm -80 dBm 17 mW	wer of +4 dBm for BR 0.001% BER -70 dBm -70 dBm -70 dBm	
Receiver Sensitivity Power Consumption Range	device with a maxin Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 1 Up to 33 ft (10 m) USB 2.0 compliant	num transmit po 0.01% BER -80 dBm -80 dBm 17 mW	wer of +4 dBm for BR 0.001% BER -70 dBm -70 dBm -70 dBm	
Receiver Sensitivity Power Consumption Range Electrical Interface Bluetooth® Software Supported	device with a maxin Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 1 Up to 33 ft (10 m) USB 2.0 compliant Microsoft Windows	num transmit po 0.01% BER -80 dBm -80 dBm 17 mW Bluetooth® Soft	wer of +4 dBm for BR 0.001% BER -70 dBm -70 dBm -70 dBm ware	
Receiver Sensitivity Power Consumption Range Electrical Interface Bluetooth® Software Supported Link Topology	device with a maxim Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 1 Up to 33 ft (10 m) USB 2.0 compliant Microsoft Windows Point to Point, Mult	num transmit po 0.01% BER -80 dBm -80 dBm 17 mW Bluetooth® Soft ipoint Pico Nets	wer of +4 dBm for BR 0.001% BER -70 dBm -70 dBm -70 dBm ware up to 7 slaves	
Receiver Sensitivity Power Consumption Range Electrical Interface Bluetooth® Software Supported Link Topology Electrical Interface	device with a maxin Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 1 Up to 33 ft (10 m) USB 2.0 compliant Microsoft Windows	num transmit po 0.01% BER -80 dBm -80 dBm 17 mW Bluetooth® Soft ipoint Pico Nets	wer of +4 dBm for BR 0.001% BER -70 dBm -70 dBm -70 dBm ware up to 7 slaves	
Receiver Sensitivity Power Consumption Range Electrical Interface Bluetooth® Software Supported Link Topology Electrical Interface Bluetooth® Software Supported	device with a maxim Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 1 Up to 33 ft (10 m) USB 2.0 compliant Microsoft Windows Point to Point, Mult	num transmit po 0.01% BER -80 dBm -80 dBm -80 dBm 17 mW Bluetooth® Soft ipoint Pico Nets of etooth® Security	wer of +4 dBm for BR 0.001% BER -70 dBm 70 dBm 70 dBm 70 dBm 70 dBm vare vare vare	
Receiver Sensitivity Power Consumption Range Electrical Interface Bluetooth® Software Supported Link Topology Electrical Interface Bluetooth® Software Supported Security	device with a maxin Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 7 Up to 33 ft (10 m) USB 2.0 compliant Microsoft Windows Point to Point, Mult Full support of Blue	num transmit po 0.01% BER -80 dBm -80 dBm -80 dBm 17 mW Bluetooth® Soft ipoint Pico Nets etooth® Security ACPI, and USB Br	wer of +4 dBm for BR 0.001% BER -70 dBm -70 dBm -70 dBm -70 dBm -70 dBm ware ware up to 7 slaves Provisions us Support	and EDR.
Receiver Sensitivity Power Consumption Range Electrical Interface Bluetooth® Software Supported Link Topology Electrical Interface Bluetooth® Software Supported Security Power Management	device with a maxim Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 1 Up to 33 ft (10 m) USB 2.0 compliant Microsoft Windows Point to Point, Mult Full support of Blue Microsoft Windows Self-configurable to	num transmit po 0.01% BER -80 dBm -80 dBm -80 dBm 17 mW Bluetooth® Soft ipoint Pico Nets etooth® Security ACPI, and USB Bi o optimize power	wer of +4 dBm for BR 0.001% BER 70 dBm 70 dBm 70 dBm 70 dBm 70 dBm 70 dBm 0.001% BER 0.0	and EDR.
Receiver Sensitivity Power Consumption Range Electrical Interface Bluetooth® Software Supported Link Topology Electrical Interface Bluetooth® Software Supported Security Power Management Power Management Certifications	device with a maxim Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 7 Up to 33 ft (10 m) USB 2.0 compliant Microsoft Windows Point to Point, Mult Full support of Blue Microsoft Windows Self-configurable to modes, including St	num transmit po 0.01% BER -80 dBm -80 dBm -80 dBm 17 mW Bluetooth® Soft ipoint Pico Nets of etooth® Security ACPI, and USB Bit o optimize powel andby, Hold, Par	wer of +4 dBm for BR 0.001% BER -70 dBm -70 dBm -70 dBm -70 dBm -70 dBm ware up to 7 slaves Provisions us Support r conservation in all o rk, and Sniff	and EDR.
Receiver Sensitivity Power Consumption Range Electrical Interface Bluetooth® Software Supported Link Topology Electrical Interface Bluetooth® Software Supported Security Power Management Power Management	device with a maxim Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 7 Up to 33 ft (10 m) USB 2.0 compliant Microsoft Windows Point to Point, Mult Full support of Blue Microsoft Windows Self-configurable to modes, including St	num transmit po 0.01% BER -80 dBm -80 dBm -80 dBm 17 mW Bluetooth® Soft ipoint Pico Nets of etooth® Security ACPI, and USB Bit o optimize powel andby, Hold, Par	wer of +4 dBm for BR 0.001% BER 70 dBm 70 dBm 70 dBm 70 dBm 70 dBm 70 dBm 0.001% BER 0.0	and EDR.
Receiver Sensitivity Power Consumption Range Electrical Interface Bluetooth® Software Supported Link Topology Electrical Interface Bluetooth® Software Supported Security Power Management Power Management Certifications	device with a maxim Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 7 Up to 33 ft (10 m) USB 2.0 compliant Microsoft Windows Point to Point, Mult Full support of Blue Microsoft Windows Self-configurable to modes, including St All necessary regulation including:	num transmit po 0.01% BER -80 dBm -80 dBm -80 dBm 17 mW Bluetooth® Soft ipoint Pico Nets of etooth® Security ACPI, and USB Bro o optimize power andby, Hold, Par atory approvals f	wer of +4 dBm for BR 0.001% BER 70 dBm 0.001% 0.000 0	and EDR.
Receiver Sensitivity Power Consumption Range Electrical Interface Bluetooth® Software Supported Link Topology Electrical Interface Bluetooth® Software Supported Security Power Management Power Management Certifications Security	device with a maxim Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend Up to 33 ft (10 m) USB 2.0 compliant Microsoft Windows Point to Point, Mult Full support of Blue Microsoft Windows Self-configurable to modes, including St All necessary regulation	num transmit po 0.01% BER -80 dBm -80 dBm -80 dBm 17 mW Bluetooth® Soft ipoint Pico Nets of etooth® Security ACPI, and USB Bro o optimize power andby, Hold, Par atory approvals f	wer of +4 dBm for BR 0.001% BER 70 dBm 0.001% 0.000 0	and EDR.
Receiver Sensitivity Power Consumption Range Electrical Interface Bluetooth® Software Supported Link Topology Electrical Interface Bluetooth® Software Supported Security Power Management Power Management Certifications Security Certifications Bluetooth® Profiles Supported	device with a maxin Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend Up to 33 ft (10 m) USB 2.0 compliant Microsoft Windows Point to Point, Mult Full support of Blue Microsoft Windows Self-configurable to modes, including St All necessary regula including: FCC (47 CFR) Part 15	num transmit po 0.01% BER -80 dBm -80 dBm -80 dBm 17 mW Bluetooth® Soft ipoint Pico Nets of tooth® Security ACPI, and USB Bit o optimize power andby, Hold, Par atory approvals f 5C, Section 15.24	wer of +4 dBm for BR 0.001% BER 70 dBm 0.001% 0.000 0	and EDR.
Receiver Sensitivity Power Consumption Range Electrical Interface Bluetooth® Software Supported Link Topology Electrical Interface Bluetooth® Software Supported Security Power Management Power Management Certifications Security Certifications	device with a maxim Modulation GFSK π/4-DQPSK 8DPSK Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 7 Up to 33 ft (10 m) USB 2.0 compliant Microsoft Windows Point to Point, Mult Full support of Blue Microsoft Windows Self-configurable to modes, including St All necessary regulation including:	num transmit po 0.01% BER -80 dBm -80 dBm -80 dBm 17 mW Bluetooth® Soft ipoint Pico Nets i etooth® Security ACPI, and USB Bi o optimize power andby, Hold, Par atory approvals f 5C, Section 15.24 00 826	wer of +4 dBm for BR 0.001% BER 70 dBm 0.001% 0.000 0	and EDR.

	UL, CSA, and CE Mark Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2}
 ertifications luetooth® Profiles Supported	Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2} Human Interface Device Profile (HID) ^{1,2} FAX Profile (FAX) Basic Imaging Profile (BIP) ² Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)

Wireless LAN Standards	IEEE 802.11a IEEE 802.11b		
	IEEE 802.11g		
	IEEE 802.11n		
	IEEE 802.11ac		
Interoperability	Wi-Fi certification		
Frequency Bands	802.11b/g/n	2.402 – 2.482 GHz	
		Note:	
		The FCC has declared as of January 1, 2015 products that utilize passive	
		scanning on channel 12/13 and are capable of transmitting must fully	
		comply with requirements of 15.247 or otherwise disable those channels.	
	802.11a/n	4.9 – 4.95 GHz (Japan)	
		5.15 – 5.25 GHz	
		5.25 – 5.35 GHz	
		5.47 – 5.725 GHz	
		5.825 – 5.850 GHz	
		Note: Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)	
Data Rates		1, 2, 5.5, 11 Mbps	
	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps		
	• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps		
		MCS 0 ~ MCS 15, (20MHz, and 40MHz) : : MCS0 ~ MCS7, (1SS) (20MHz, 40MHz, and 80MHz)	
	• 802.11a	י ארטיי איז איז איז איז איז איז איז איז איז א	
Modulation	Direct Seque	nce Spread Spectrum	



	BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through CCX4 and CCX Lite WAPI
	¹ Check latest software/driver release for updates on supported security features.
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	802.11r Fast Roaming
Output Power ²	 802.11b : +16dBm minimum 802.11g : +14dBm minimum 802.11a : +14dBm minimum 802.11a : +14dBm minimum 802.11n HT20(2.4GHz) : +14dBm minimum 802.11n HT40(2.4GHz) : +12dBm minimum 802.11n HT20(5GHz) : +14dBm minimum 802.11n HT40(5GHz) : +12dBm minimum 802.11n HT40(5GHz) : +12dBm minimum
	² Maximum output power may vary by country according to local regulations.
Power Consumption	Transmit: 2.0 W (max) Receive: 1.6 W (max) Idle mode (PSP): 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connect Standby: 10 mW (WLAN+BT) Radio disabled: 5 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity ³	802.11b, 1Mbps : -94dBm maximum 802.11b, 11Mbps : -86dBm maximum 802.11g, 6Mbps : -88dBm maximum 802.11g, 54Mbps : -74dBm maximum 802.11a, 6Mbps : -88dBm maximum 802.11a, 54Mbps : -74dBm maximum 802.11n, MCS07 : -69dBm maximum 802.11n, MCS15 : -66dBm maximum 802.11ac, 1SS, MCS-0 : -86dBm maximum 802.11ac, 1SS, MCS-9 : -61dBm maximum



	802.11ac, 2SS, MCS-0 : -83dBm maximum 802.11ac, 2SS, MCS-9 : -58dBm maximum			
	³ Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).			
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth [®] communications			
Form Factors	PCI-Express M.2 MiniCard			
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm Or Type 1630 : 2.3 x 16.0 x 30.0 mm			
Weight	Type 2230 : 2.8g Or Type 1630 : 2g			
Operating Voltage	3.3v +/- 9%			
Temperature	Operating: 14° to 158° F (-10° to 70° C) Non-operating: -40° to 176° F (-40° to 80° C)			
Humidity	Operating:10% to 90% (non-condensing)Non-operating:5% to 95% (non-condensing)			
Altitude	Operating: 0 to 10,000 ft (3,048 m) Non-operating: 0 to 50,000 ft (15,240 m)			
LED Activity	LED Amber – Radio OFF; LED White – Radio ON			
* Wireless access point and Inte	rnet service required and not included. A	vailability of public wireless access points limited.		
HP Integrated Module with Bl	uetooth® 4.0/4.1/4.2 Wireless Technolo	gy		
Bluetooth [®] Specification	4.0/4.1/4.2 Compliant			
Frequency Band	2402 to 2480 MHz			
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)			
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps			
	BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels			



	Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) o 864 kbps symmetric (3-EV5)			
Transmit Power	The Bluetooth [®] component shall operate as a Class II Bluetooth [®] device with a maximum transmit power of + 4 dBm for BR and EDR.			
Receiver Sensitivity	Modulation	0.01% BER	0.001% BER	
Legacy	GFSK	-80 dBm	-70 dBm	
	π/4-DQPSK	-80 dBm	-70 dBm	
	8DPSK	-80 dBm	-70 dBm	
Power Consumption	Peak (Tx) 330 mW			
	Peak (Rx) 230 mW			
	Selective Suspend 1	7 mW		
Range	Legacy Up to 33 ft (1 BLE Up to 99 ft (30 n			
Electrical Interface	USB 2.0 compliant			
Bluetooth® Software Supported Link Topology	Microsoft Windows Bluetooth [®] Software			
Electrical Interface Bluetooth® Software Supported Security	Point to Point, Multi	point Pico Nets up '	to 7 slaves	
	Full support of Bluet	ooth [®] Security Pro	visions	
Power Management Certifications	Microsoft Windows ACPI, and USB Bus Support			
	Self-configurable to Hold, Park, and Sniff	• •	nservation in all opera	ating modes, including Standby,
Security	All necessary regulatory approvals for supported countries, including:			
Certifications Bluetooth® Profiles Supported	FCC (47 CFR) Part 15C, Section 15.247 & 15.249			
Power Management Certifications	ETS 300 328, ETS 300 826			
	Low Voltage Directiv	ve IEC950		
Certifications	UL, CSA, and CE Mark			
Bluetooth [®] Profiles Supported	Serial Port Profile (SPP) ¹			
σαμμοιτεα	Service Discovery Application Profile (SDAP)			
	Dial-Up Networking (DUN) ^{1,2}			
	Generic Object Exchange Profile (GOEP) ^{1,2}			



	Object Push Profile (OPP) ^{1,2} Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2} Human Interface Device Profile (HID) ^{1,2} Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) Audio Video Remote Control Profile (AVRCP)
Bluetooth [®] V4.1/V4.2 support	V4.1: ESR5/6/7 compliant
feature	V4.2: ESR8 compliant, LE Secure Connection – Basic.



Technical Specifications - Audio

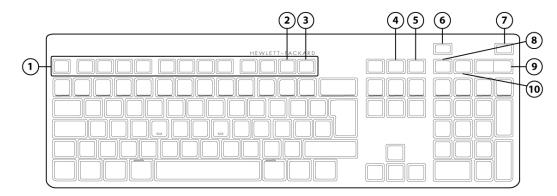
AUDIO

High Definition Audio – MT/SFF/DM

Туре	Integrated		
HD Stereo Codec	Conexant CX20632		
Audio I/O Ports	Headset connector supports a CTIA style headset and is re-taskable as a Line-in, Line-out, Microphone-in or Headphone-out port		
	Rear Line-In can be retasked to function as a microphone input		
	Rear Line-Out		
	All ports are 3.5mm and support stereo (see above tables for system configurations)		
Internal Speaker Amplifier	2W class D mono amplifier for the internal speaker only External speakers must be powered externally.		
Multi-streaming Capable	Playback multi-streaming can be enabled in the audio control panel to allow independent aud streams to be sent to/from the front and rear jacks or integrated speaker.		
Sampling	Independent sampling rates for DAC's and ADC's; supports resolutions from 16 to 24-bit; 44.1 kHz to 192 kHz for DAC and 44.1 kHz to 96 kHz for ADC		
Wavetable Syntheses	Yes – Uses OS soft wavetable		
Analog Audio	Yes		
# of Channels on Line-Out	Stereo (Left & Right channels)		
Internal Mono Speaker	Yes		

INPUT/OUTPUT DEVICES

HP Conferencing Keyboard



1.	Function Keys			End/Decline a Call		
2.	F11 Lync or Skype for Business Contact list *		7.	Answer a Call		
3.	F12 Lync or Skype for Bu	isiness Calendar **	8.	Microphone Mute		
4.	Share Screen		9.	Volume Up/Down		
5.	Stop Webcam		10.	Audio Mute		
*M	icrosoft Lync 2013, or Sky	pe for Business, or Microsoft Outlook 2013	3 Conta	ict list		
**M	icrosoft Lync 2013, or Sky	pe for Business, or Microsoft Outlook 2013	3 Calen	dar		
Dim	ensions (H x L x W)	0.85 x 17.34 x 6.10 in (2.16 x 44.05	x 15.50) cm)		
Wei	ght	24.69 oz. (700 g)				
Con	nectivity	USB cable				
Key	S	110 (US) Layout, 111 (EU) Layout – depending upon country				
Fea	ture Summary	mmaryFull-size ultra-quiet keyboard with numerical pad and 12 function keysOne-touch simplicity for Microsoft Lync or Skype for Business calls with dedicated keys and LEDlight indicators				
Illu	Illuminated keys Incoming Call – Blinks Green Call in progress –Green Microphone Mute – Orange Audio Mute – Orange Screen Sharing – Orange Stop Webcam – Orange Stop Webcam – Orange					
	ther Call control keys End/Decline Call					



	Volume up and down rocker key
Microsoft Lync/Outlook	Fn+F12 – Lync or Skype for Business Calendar will open. If Lync or Skype for Business is not available will bring Outlook Calendar * Fn+F11 – Lync or Skype for Business Contact will open. If Lync or Skype for Business is not available will bring Outlook Contact list *
	* Fn+11 and Fn+12 function keys are not supported in Microsoft Windows 8.x Metro mode
Functions Keys	Fn+F10 – System Settings Fn+F9 – Devices Fn+F8 – Search Fn+F7 – Blank Fn+F6 – Up Brightness Adjustment Fn+F5 – Down Brightness Adjustment Fn+F4 – Display Options Fn+F3 – File Explorer Fn+F2 – System Lock Fn+F1 – System Sleep
System requirements	 Available USB port Windows 7, Windows 8.x, and Windows 10 Server: Microsoft Lync Server 2010 or 2013 and Skype for Business Server 2015 Client: Microsoft Lync 2013 version 15.0.46xx or newer or Skype for Business Notes: Limited support for Microsoft Lync 2010, Microsoft Lync 2013 Basic and Microsoft Metro Mode Screen brightness functions supported in select HP systems
Approvals EMC Product Safety	FCC; CE; ACA(C-tick); EAC UL, CE Mark

HP USB PS/2 Washable Keyboard				
Physical Characteristics	Keys	104 (US) Layout, 105 (EU) layout – depending upon country		
	Dimensions (L x W x H)	17.67x 6.62 x 1.38 in (449 x 168 x 35 mm)		
	Weight	1.7 lb (0.77 kg) minimum		
	Operating voltage	+ 5VDC ±5%		
	Power consumption	50-mA maximum (with three LEDs ON)		
	System interface	USB Type A plug connector		
Electrical	ESD	CE level 4, 15-kV air discharge		
	EMI - RFI	Conforms to FCC rules for a Class B computing device		
	Microsoft PC 99 - 2001	Functionally compliant		
Mechanical	Keycaps	Stepped -profile design		



	Switch actuation	55-g nominal peak force with tactile feedback	
	Switch life	20 million keystrokes	
	Switch type	Contamination-resistant switch membrane	
	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	7 ft (2.2 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
	Acoustics	43-dBA maximum sound pressure level	
	Operating temperature	50° to 122° F (10° to 50° C)	
	Non-operating temperature 4° to 149° F (-20° to 65° C)		
	Operating humidity	10% to 95% (non-condensing at ambient)	
	Non-operating humidity	0% to 95% (non-condensing at ambient)	
Environmental	Operating shock	40 g, six surfaces	
	Non-operating shock	80 g, six surfaces	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration	4-g peak acceleration	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence	
Operating system support	Windows® 7, Windows Vista, Win	dows XP Professional	
Approvals	UL, cUL, FCC, CE, TUV GS, VCCI, BSMI, C-Tick, KCC, USB-IF, WHQL, EN/IEC 60601-1, IP66/NEMA4X		
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS		
HP USB Business Slim Sı	martcard Keyboard		
	Keys	104, 105, 109 layout	
Dhusiaal Chava stavistics	Dimensions	(depending upon country 17.34 x 5.68 x 0.78 in (440.6 x 14.45 x 1.98 cm)	
Physical Characteristics	Dimensions (H x W x D)	17.34 X 5.68 X 0.78 m (440.6 X 14.45 X 1.98 cm)	
	Weight	1.32 lb (0.6± 0.1 kg)	
	Operating voltage	5V	
	Power consumption	200 mA	
Electrical	System interface	USB Interface	
	ESD	Air 12.5kV / Contact 8kV	
	EMI - RFI	under 3dB	
	Microsoft PC 99 - 2001	Conforms to FCC rules for a Class B computing device	
	Кеусарѕ	Low-profile design	
	Switch actuation	60±15g nominal peak force with tactile feedback	
Mechanical	Switch life	10 million keystrokes (Life tester)	
	Switch type Contamination-resistant switch membrane		
	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	6 ft (1.8 m)	
Environmental	Acoustics	43-dBA maximum sound pressure level	
	Operating temperature	50° to 122° F (10° to 50° C)	



Γ	Non-operating temperature	-22° to 140° F (-30° to (εο° Γ)	
	Operating humidity	5 1		
	Non-operating humidity	20% to 80% (non-condensing at ambient)		
	Operating shock	40 g, six surfaces		
	Non-operating shock 80 g, six surfaces			
		Operating vibration 2-g peak acceleration		
	Non-operating vibration	4-g peak acceleration		
	Drop (out of box)	26 in (66 cm) on carpet	, six-drop sequence	
	Drop (in box)	30 in (76.2 cm) on conc	rete, 16-drop sequence	
	Support	All ISO 7816 smart card	ls	
	Interface		to all ISO7816-1, 2, 3, 4 memory	
		and microprocessor sm	art cards (T=0, T=1)	
	Chipset	IDENTIVE CLOUD 2190		
	Standard APIs supported	PC/SC, EMV2000, CT-A	2	
	Power	USB Port		
		Short circuit detection (protects smart card and reader)		
		Power supply compliant with ISO7816 and EMV (5V, 60 mA)		
SmartCard Function		Supports 3-V and 5-V c	ards	
	Power consumption	100-mA maximum draw		
	Communication	From card	9600 bps to 330,000 bps	
		From computer	12 Mbps (USB transfer speed)	
	Landing mechanism	Contact device	Friction contact	
		Card insertions rating	Up to 100,000 insertion cycles	
	Interface modes	CCID protocol		
	Reader performance interface	USB connection		
	Electro-magnetic standards	Europe	2004/108/EC	
		USA	USAFCC part 15	
Approvals	CE Marking; TUV; EAC; FCC; cULus	/CSAus; ICES; RCM; VCCI; KC	C; BSMI	
Ergonomic Compliance	ISO 9241-410, TUV GS			
Kit Contents	Keyboard, I/O Security and Documentation CD, warranty card			
HP USB Business Slim	Keyboard			
	Keys	104, 105, 106, 107, 109 layout (depending upon count		
Physical characteristics	Dimensions (L x W x H)	171.97 x 68.35 x 8.27 ir 1.0 cm)	n (436.8± 1.5 x 137.6± 1.0 x 21.0±	

Electrical

Weight

Operating voltage

Power consumption

1.32 lb (0.6± 0.08 kg)

50-mA maximum (with 5 VDC power supplied and three

+ 4.4 - 5.25VDC

LEDs ON)

	System interface	USB Type A plug connector	
	ESD	Contact Discharge: 2, 4,6,8KV	
	ESD	Air Discharge: 2, 4, 8,10,12.5KV	
	EMI - RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft [®] PC 99 - 2001	Functionally compliant	
	Кеусарѕ	Low-profile design	
	Switch actuation	60±12.5g nominal peak force with tactile feedback	
	Switch life	10 million keystrokes (Life tester)	
Mechanical	Switch type	Contamination-resistant switch membrane	
	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	6 ft (1.8 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
	Acoustics	43-dBA maximum sound pressure level	
	Operating temperature	50° to 122° F (10° to 50° C)	
	Non-operating temperature	-22° to 140° F (-30° to 60° C)	
	Operating humidity	10% to 90% (non-condensing at ambient)	
	Non-operating humidity	20% to 80% (non-condensing at ambient)	
Environmental	Operating shock	40 g, six surfaces	
	Non-operating shock	80 g, six surfaces	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration	4-g peak acceleration	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
	Drop (in box)	30 in (76.2 cm) on concrete, 16-drop sequence	
Approvals	UL, FCC, CE Mark, TUV, TUV GS, VC	CI, BSMI, C-Tick, KC	
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS		



Kit contents	Keyboard	Installation Guide	
	Warranty Card	Safety and Comfort Guide	
HP PS/2 Business Slim H	Keyboard		
	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
Physical Characteristics	Dimensions (L x W x H)	171.97 x 68.35 x 8.27 in (436.8± 1.5 x 137.6± 1.0 x 21.0± 1.0 cm)	
	Weight	1.32 lb (600± 80 g)	
	Operating voltage	+ 4.4 – 5.25VDC	
	Power consumption	50-mA maximum (with 5 VDC power supplied and three LEDs ON)	
	System interface	PS/2 6-pin mini din connector	
	ESD	Contact Discharge: 2, 4,6,8KV	
	220	Air Discharge: 2, 4, 8,10,12.5KV	
	EMI - RFI	Conforms to FCC rules for a Class B computing device	
Electrical	Microsoft PC 99 - 2001	Functionally compliant	
	Кеусарѕ	Low-profile design	
	Switch actuation	60±12.5g nominal peak force with tactile feedback	
	Switch life	10 million keystrokes (Life tester)	
	Switch type	Contamination-resistant switch membrane	
	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	6 ft (1.8 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
	Acoustics	43-dBA maximum sound pressure level	
Environmont-1	Operating temperature	50° to 122° F (10° to 50° C)	
Environmental	Non-operating temperature	-22° to 140° F (-30° to 60° C)	
	Operating humidity	10% to 90% (non-condensing at ambient)	



	Non-operating humidity	20% to 80% (non-condensing at ambient)	
	Operating shock	N/A	
	Non-operating shock	65 inch 2.9 ms, six surface; 30g 266 inch/second; 50g 266 inch/second six surface	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration	Starting at 5 Hz, vary the frequency of vibration from 5 to 500 Hz and back to 5 Hz at a Logarithmic sweep rate of 1 octave per minute.	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
	Drop (in box)	29.93 in (76 cm) on concrete, 16-drop sequence	
Approvals	UL, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, KC		
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS		

HP USB (Grey) Business Slim Keyboard

Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)
	Dimensions (L x W x H)	17.19 x 5.41 x 0.82 in (43.68±1.5 x 13.76±1.0 x 2.1 ±1.0 cm)
	Weight	1.32 lb (0.6± 0.08 kg)
Electrical	Operating voltage	+ 4.4 – 5.25VDC
	Power consumption	100-mA maximum (with 5 VDC power supplied and three LEDs ON)
	System interface	USB Type A plug connector
	ESD	Contact Discharge: 4, 6, 8 KV
	EMI – RFI	Air Discharge: 8, 10, 12 KV / 15 KV
	Microsoft PC 99 – 2001	Conforms to FCC rules for a Class B computing device; Functionally compliant
Mechanical	Keycaps	Low-profile design
	Switch actuation	Rubber dome + membrane
	Switch life	10 million
	Switch type	Rubber dome
	Key-leveling mechanisms	Link bar
	Cable length	For all double-wide and greater-length keys
	Microsoft PC 99 – 2001	Yes
Environmental	Acoustics	55-dBA maximum sound pressure level
	Operating temperature	10°C to 50°
	Non-operating temperature	-30°C to 90°
	Operating humidity	10% to 90% (non-condensing at ambient)
	Non-operating humidity	60% to 80% (non-condensing at ambient)
	Operating shock	40 g, six surfaces



	Non-operat	ing shock	80 g, six surface	25	
	Operating v	ibration	2-g peak accele	ration	
	Non-operat	ing vibration	4-g peak accele	ration	
	Drop (out of	f box)	26 in (66 cm) on carpet, six-drop sequence		
	Drop (in boy		30 in (76.2 cm) on concrete, 16-drop sequence		
Approvals			; RCM; TUV-GS; L	JL; RoHS; WEEE	
Ergonomic compliance	ANSI HES 10	00; ISO 9241-4;	and TUVGS		
HP Wireless Busin	iess Slim H	Keyboard a	n d Mouse		
Keyboard	Di	mensions (L x \	W x H)	171.97 x 68.35 x 8.27 in (436.8± 1.5 x 137.6± 1.0 x 21.0± 1.0 cm)	
Reyboard		eight – Without kaline Batteries		1.23 lb (560± 80 g)	
	Di	mensions (H x L	. x W)	1.46 x 4.53 x 2.47 in (37 x 115 x 62.9 mm)	
Mouse		eight – Without kaline Batteries		0.15 lb (67 g)	
	Di	Dimensions (H x L x W)		0.33x 1.79 x 0.72 in (8.4 x 45.5 x 18.4 mm)	
	W	Weight		0.21 oz (5.9 g)	
Receiver	Ca	Cable Length – Minimum		6 ft (1.8 m)	
		Range		32.8 ft (10 m)	
System Requirements		Available USB port for the receiver CD-ROM Drive			
		*This system may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.			
	Pr	oduct Safety		UL; CSA /TUV (Europe only); CE Mark; CB Report	
	Er	Ergonomics		ANSI; ISO (Europe only); GS Mark (Germany only)	
	EN	EMC		FCC; CE; ACA (-tick); BSMI; KC ; VCCI	
	CE	CE Mark		EN 55022:2010; EN 55024; EN 301489-1; EN 61000	
Approvals	De	esign Guidelines	for PCs	PC 99 – connector overmold colors; PC 2001 – full functionality	
	Te	Telecom		All local telecom requirements and approvals for intended markets	
		5A		FCC Title 47 CFR, Par 15, Subpart C; other local requirements	



	Country Support	US, Belgium, Switzerland, Spain, Denmark, Netherlands, France, Germany, Italy, Portugal, Sweden, Norway, Finland, UK, Poland, Czech Republic, Turkey, Greece, Austria, Bulgaria, Cyprus, Estonia, Hungary, Ireland, Latvia, Lithuania, Luxemburg, Malta, Romania, Slovakia, Slovenia, Vietnam, HK, Australia, NZ, Malaysia, Singapore, Indonesia, Philippines, Thailand, Canada, China, Japan, Korea, Taiwan, India, Venezuela, Ecuador, Russia, Ukraine, Israel, Croatia, United Arab Emirates, Peru, Brazil, Chile, Argentina, Mexico, South Africa, and up to 193 countries worldwide.
Environmental	Keyboard contains 25% post-consumer recycled plastic material.	

HP PS/2 Mouse				
Dimensions (H x L x W)	1.46 x 2.48 x 4.53 in (3.70 x 6.29 x 11.50 cm)			
Weight	3.53 oz (100g; +10g/- 5 g)			
	Operating temperature	-32° to 104°F (0° to 40° C)		
	Non-operating temperature	-4° to 140°F (-20° to 60° C)		
	Operating humidity	10% to 90% (non condensing at ambient)		
	Non-operating humidity	10% to 90% (non condensing at ambient)		
Environmental	Operating shock	40 g, 6 surfaces		
	Non-operating shock	80 g, 6 surfaces		
	Operating vibration	2 g peak acceleration		
	Non-operating vibration	4 g peak acceleration		
	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5- drop in 5 direction except the cable face		
	Operating voltage	5 VDC ± 10%		
	Power consumption	100mA		
Electrical	System consumption	PS/2 mini-din connector		
Electrical	ESD	CE level 4, 15 kV air discharge		
	EMI-RFI	Conforms to FCC rules for a Class B computing device		
	Microsoft PC99 - 2001	Functionally compliant		
	Resolution	800 DPI		
	Tracking speed	10 in/s (25.4 cm/s) maximum		
Mechanical	Acceleration	±15%		
	Switch actuation	65±20 gf		
	Switch life	3,000,000 operations (using Hasco modified tester)		



	Switch type		Low force micro-switches	
	Tracking mechanisr	n life	80 km	
	Cable length	intine	6 ft (1.8 m)	
	Microsoft PC99 - 20	01	Mechanically compliant	
	Width		6 mm	
	Diameter	•	22.5 ± 0.2 mm	
Scroll wheel	Maximum rotation f	orce	50 gf-cm	
	Switch type		Light force micro-switch	
	Switch life		1 million operations	
	Mechanical life		Minimum 200,000 revolutions	
Regulatory Approvals	UL/cUL, FCC, CE Mar	k, TUV/GS, V	/CCI, KCC, BSMI, C-Tick	
HP USB 1000dpi La	iser Mouse			
Dimensions (H x L x W)	1.47 x 4.53 x 2.47 ir	ו (37.3 x 114	97 x 62.86 mm)	
Weight	3.360 oz (102g)			
Cable length	70.9 in (180 cm)			
System requirements	Available USB port			
Environmental	Operating Tempera	ture	32° to 104° F (0° to 40° C)	
	Non-operating Tem	perature	-4° to 140° F (-20° to 60° C)	
	Operating Humidity		10% to 90% (non-condensing at ambient)	
Mechanical	Resolution		1000dpi	
	Tracking Speed		45 cm/sec	
	Cable Length		70.9 in (180 cm)	
HP USB PS/2 Washa	able Mouse		·	
Dimensions (H x L x W)	1.56 x 2.44 x 4.61 in (3.95	5 x 6.21 x 11.	.7 cm)	
Weight	4.44 oz (126 g)			
Environmental	Operating temperature		4°F (0° to 40° C)	
	Non-operating temperature	–4° to 140	°F (–20° to 60° C)	
	Operating humidity	10% to 90	0% (non-condensing at ambient)	
	Non-operating humidity	10% to 90	0% (non condensing at ambient)	
	Operating shock	40 g, 6 sur	faces	
	Non-operating shock	80 g, 6 sur	faces	
	Operating vibration	2 g peak a	cceleration	
	Non-operating vibration	4 g peak acceleration		



	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face
Electrical	Operating voltage	5 VDC ± 10%
	Power consumption	100mA
	System consumption	PS/2 mini-din connector
	ESD	CE level 4, 15 kV air discharge
	EMI-RFI	Conforms to FCC rules for a Class B computing device
	Microsoft [®] PC99 – 2001	Functionally compliant
Mechanical	Resolution	400 ± 20% DPI
	Tracking speed	10 in/s (25.4 cm/s) maximum
	Acceleration	100 in/s/s (2.54 m/s/s)
	Switch actuation	61 g nominal peak force
	Switch life	3,000,000 operations (using Hasco modified tester)
	Switch type	Low force micro-switches
	Tracking mechanism life	155 mi (250 km) at average speed of 10 in/s
	Cable length	6 ft (1.8 m)
	Microsoft PC99 – 2001	Mechanically compliant
Scroll wheel	Width	8 mm
	Diameter	1.01 in (25.6 mm)
	Maximum rotation speed	48 rats/sec
	Switch type	Light force micro-switch
	Switch life	1 million operations
	Mechanical life	Minimum 200,000 revolutions
Regulatory approvals	Compliant	UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

HP USB Harder	ned Mouse		
Mouse Type	Wired optical mouse		
Interface	USB 2.0		
Dimensions (H x L x W)	114.97 x 62.92 x 37. (11.49 x 6.29 x 1.46 i		
Weight	92 g (+/-10 g) (3.2 oz)		
Cable length	1.8 M		
Tracking	X-Y Positioning	X-Y Wheel Resolution	1000 DPI
		Tracking Speed	Up to 30 in/sec in either X or Y direction



	Z Axis Wheel	Z Wheel Revolution	24 counts per revolution	
		Tracking Speed	0 ~ 120 rpm	
Environmental	Operating temperature	0° - 40°C		
	Non-operating temperature	-40° - 65°C		
	Operating humidity	90%		
	Agency Approvals	CE FCC RCM VCCI EMC EAC BSMI UL ICES-003 Cla KCC TUV/GS		
Electrical	Input Voltage & Current	4.4 ~ 5.25 VDC / 100 mA		
	Power Consumption		nal 5 VDC power supplied, max current consumption is 100mA g speed up to 30 in/sec	
Color	Black			
System requirements	Windows 10, Windows 8.	1 32/64bit, Wi	indows 7 32/64bit	

HP Grey V2 Mouse	2		
Dimensions (H x L x W)	1.46 x 4.53 x 2.48 in (3.72 x 11	1.46 x 4.53 x 2.48 in (3.72 x 11.5 x 6.29 cm) ±1 mm	
Weight	3.53 oz (100g; +10g/- 5 g)	3.53 oz (100g; +10g/- 5 g)	
	Operating temperature	50° to 122°F (10° to 50° C)	
	Non-operating temperature	-22° to 140°F (-30° to 60° C)	
	Operating humidity	10% to 90% (non condensing at ambient)	
Environmental	Non-operating humidity	20% to 80% (non condensing at ambient)	
	Operating shock	40 g, 6 surfaces	
	Non-operating shock	80 g, 6 surfaces	
	Operating vibration	2 g peak acceleration	
	Non-operating vibration	4 g peak acceleration	
Electrical	Operating voltage	4.75~5.25 Vdc	
Electrical	Power consumption (typical)	10mA	
Mechanical	Connector	USB 2.0	



	Туре	3D mouse (3 keys and wheel)	
	Resolution	800 DPI	
	Sensor	PixArt vendor Optical USB mouse sensor. DIP	
	Tracking speed	30 inch/sec (max)	
	Tracking acceleration	8G(max), 1G=9.8m/s2	
	Cable length	6 ft (1.8 m)	
Color	Grey		
Regulatory Approvals	FCC, CE, ICES, C-TICK, VCCI, KCC, BSMI, ISO9241, Part 4, Computer Work Station Ergonomics compliance, IEC 801-2, IEC 1000-4-2, EN 55024:1998 + A1:2001 + A2:2003, European Stand EN 55022: 2006 Class B, CE Mark		

HP USB Mouse				
Dimensions (H x L x W)	2.5 x 4.5 x 1.5 in (63.5	2.5 x 4.5 x 1.5 in (63.5 x 114.3 x 38.1 mm)		
Weight	0.22 lb (99.79 g)	0.22 lb (99.79 g)		
Color	Black	Black		
Connector	USB	USB		
Mechanical	Resolution	Resolution 800 DPI sensitivity		
	Buttons	Two primary buttons and clickable scroll wheel		



Technical Specifications – Miscellaneous Features

MISCELLANEOUS FEATURES

Management Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel[®] Wired for Management support; industry wide initiative to make Intel[®] architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
 - Power LED will blink red 2 to 5 times, then blink white 2 or more times, then repeat (with beep tones for each blink initially):
 - 2 red + 2 white User must provide file for BIOS recovery (USB storage, typically)
 - 2 red + 3 white User must enter a key sequence to proceed with recovery by policy
 - 2 red + 4 white BIOS recovery is in progress
 - 3 red + 2 white Memory could not be initialized
 - 3 red + 3 white Graphics adapter could not be found
 - 3 red + 4 white Power supply failure / not connected
 - 3 red + 5 white Processor not installed
 - 3 red + 6 white Current processor does not support an enabled feature
 - 4 red + 2 white Processor has exceeded its temperature threshold / system thermal shutdown
 - 4 red + 3 white System internal temperature has exceeded its threshold
 - 5 red + 2 white System controller firmware is not valid
 - 5 red + 3 white System controller detected BIOS is not executing
 - 5 red + 4 white BIOS could not complete initialization / PCA failure
 - 5 red + 5 white System controller rebooted the system after a health or recovery timer triggered
- HP PC Hardware Diagnostics UEFI:
 - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- BIOS recovery files are maintained on the local OS drive when updating with HP BIOS Update and Recovery utility (HPBIOSUPDREC) 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Dual Color Power and HD LED To Indicate Normal Operations and Fault Conditions
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy Identification



Technical Specifications – Environmental

Additional Features	Description		
Towerable Orientation	Product can be oriented as either a desktop (horizontal) or a tower (vertical)		
Drive Lock	Implementation of the industry standard ATA Security feature set. When enabled, it prevents software access to user data on the drive until one or two user-defined passwords are provided.		
Boot Sectors Protection	MBR or GPT boot sectors of the hard drive are critical to securely starting the operating system. By saving the MBR or GPT data (depending on the how the OS was installed), the BIOS will be able to monitor for changes and allow the user to override them with the backup copy at boot-up.		
	DPS Access through F10 Setup during Boot		
	A diagnostic hard drive self-test. It scans critical physical components and every sector of the hard drive for physical faults and then reports any faults to the user		
Drive Protection System	Running independently of the operating system, it can be accessed through a Windows-based diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and needs to be replaced		
	The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures		
SMART Technology (Self-Monitoring, Analysis and Reporting Technology)	Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted		
SMART I - Drive Failure Prediction	Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry count		
SMART II - Off-Line Data Collection	By avoiding actual hard drive failures, SMART hard drives act as "insurance" against unplanned user downtime and potential data loss from hard drive failure		
SMART III - Off-Line Read Scanning with	IOEDC: I/O Error Detection Circuitry		
Defect Reallocation	Detects errors in Read/Write buffers on HDD cache RAM		
SMART IV - End-to-End CRC for hard drives	Interface in F10 setup provides confirmation of SMART IV support.		



After-Market Options (availability may vary by region)

After Market Options

Business Monitors (sample list)*	<u>SFF/MT</u>	DM	Part Number
HP ProDisplay P240va 23.8-inch Monitor	X	Х	N3H14AA
HP ProDisplay P232 23-inch Monitor	X	Х	K7X31AA
HP ProDisplay P222c 21.5-inch Video Conferencing Monitor	X	Х	L4J08AA
*Additional models are available.			
Communication Devices	<u>SFF/MT</u>	DM	Part Number
Intel® Ethernet I210 - T1 Gbe NIC	X		E0X95AA
Intel® 7265 802.11ac 2x2 DualBand Combo PCIe x1 Card	X		N4G85AA
Graphics Solutions	<u>SFF/MT</u>	DM	Part Number
NVIDIA® GeForce® GT 730 2GB DP PCIe x8 Card	X		Z9H51AA
NVIDIA® GeForce® GT 730 1GB HDMI PCIe x8 Card	X		
AMD® Radeon™ R7 450 4GB PCIe x16 Card	MT Only		Z9H52AA
HP UHD USB Graphics Adapter	X	Х	N2U81AA
HP DisplayPort™ Cable Kit	X	Х	VN567AA
HP DisplayPort™ To DVI-D Adapter	X	Х	FH973AA
HP DisplayPort™ To VGA Adapter	X	Х	AS615AA
HP DisplayPort™ To HDMI 4k Adapter	X	Х	K2K92AA
HP DVI to DVI Cable	X	Х	DC198A
HP (Bulk) 700mm DisplayPort™ Cable Kit		Х	V8Y77A6
HP USB-C to VGA Adapter (when Type-C Port is installed)	Х	Х	N9K76AA
HP USB-C to HDMI Adapter (when Type-C Port is installed)	Х	Х	N9K77AA
HP USB-C to DisplayPort™ Adapter (when Type-C Port is installed)	X	Х	N9K78AA
Data Storage Drives	<u>SFF/MT</u>	DM	Part Number
HP 500GB 7200PRM SATA 6.0Gb/s 3.5" Hard Drive	X		QK554AA
HP 1TB 7200rpm SATA 6Gb/s 3.5" Hard Drive	X		QK555AA
HP 256GB SATA TLC Solid State Drive	X	Х	P1N68AA
HP 512GB Turbo Drive G2 TLC M.2 SSD Drive	X	Х	X8U75AA
HP 9.5mm Slim Removable SATA 500GB	X		T7G14AA
HP 256GB SATA Non-SED Solid State Drive	X	Х	W0U55AA
HP 9.5mm G3 800/600 Tower DVD Writer	MT Only		1CA52AA
HP 9.5mm G3 8/4 SFF G4 400 SFF/MT DVD Writer	SFF Only		1CA53AA
Input Devices	<u>SFF/MT</u>	DM	Part Number
HP Conferencing Keyboard	X	X	K8P74AA
HP USB Business Slim Keyboard		<u>х</u>	N3R87AA



After-Market Options (availability may vary by region)

HP PS/2 Business Slim Keyboard	x		N3R86AA
HP Wireless Business Slim Keyboard and Mouse**	X	Х	QY449AA
HP USB Business Slim Grey Keyboard (EMEA only)	X	Х	Z9H49AA
HP USB Business Slim Smart Card CCID Keyboard	X	Х	Z9H48AA
HP USB PS/2 Washable Keyboard and Mouse Kit**	X	Х	BU207AA
HP USB Grey V2 Mouse (EMEA only)	X	Х	Z9H74AA
HP USB Business Slim Keyboard and Mouse (China Only)	X	Х	Z9H50AA
HP USB Hardened Mouse	X	Х	P1N77AA
HP PS/2 Mouse	X		QY775AA
HP USB Mouse	X	Х	QY777AA
HP USB 1000dpi Laser Mouse	X	Х	QY778AA
** Keyboard contains 25% post-consumer recycled plastic material			
Desktop Mini Accessories	<u>SFF/MT</u>	DM	Part Number
HP Desktop Mini DVD Super Multi-Writer ODD Expansion Module		Х	K9Q83AA
HP Desktop Mini 500GB HDD/ I/O Expansion Module		Х	K9Q82AA
HP Desktop Mini Rack Mount Tray Kit		Х	G1K21AA
HP Desktop Mini Security/Dual VESA Sleeve		Х	G1K22AA
HP Desktop Mini 65W Power Supply Kit		Х	L2X04AA
HP Desktop Mini 90W Power Supply Kit		Х	L4R65AA
HP Desktop Mini Vertical Chassis Stand		Х	G1K23AA
HP Desktop Mini Lock Box		Х	P1N78AA
HP Desktop Mini Port Cover Kit		Х	P3R65AA
HP Desktop Mini I/O Expansion Module		Х	K9Q84AA
HP Integrated Work Center Desktop Mini/Thin Clients		Х	G1V61AA
HP Single Monitor Arm		Х	BT861AA
HP Quick Release Bracket		Х	EM870AA
System Memory	<u>SFF/MT</u>	DM	Part Number
HP 4GB DDR4-2400 DIMM	X		Z9H59AA
HP 8GB DDR4-2400 DIMM	X		Z9H60AA
HP 16GB DDR4-2400 DIMM	X		Z9H57AA
HP 4GB DDR4-2400 SODIMM		Х	Z9H55AA
HP 8GB DDR4-2400 SODIMM		Х	Z9H56AA
HP 16GB DDR4-2400 SODIMM		Х	Z9H53AA



After-Market Options (availability may vary by region)

Multimedia Devices	<u>SFF/MT</u>	DM	Part Number
HP Business Headset v2	X	Х	T4E61AA
HP USB Business Speakers v2	X	Х	N3R89AA
Security Devices	<u>SFF/MT</u>	DM	Part Number
HP 600 G3 SFF Solenoid Lock and Hood Sensor	SFF only		1CA50AA
HP 600 G3 MT Solenoid Lock and Hood Sensor	MT only		J6L42AA
HP Business PC Security Lock v2 Kit	X		N3R93AA
HP Keyed Cable Lock 10mm Kit	Х	Х	T1A62AA
HP Dual Head Keyed Cable Lock Kit	X	Х	T1A64AA
Stands and Accessories	<u>SFF/MT</u>	DM	Part Number
HP (10 Set) 600/800 G3 Tower Bezel Support Kit	Tower only		Z9H63A6
HP (10) 400 G4 600/800 G3 SFF G4 MT Bezel Support Kit	SFF only		Z9H64A6
HP Single Monitor Arm	X	Х	BT861AA
LANDESK Software (e-delivery)	<u>SFF/MT</u>	DM	Part Number
Contact your HP representative for available options.			N/A

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Change Log

Date of change:	Version History:		Description of change:
January 25,	Version 1 to 2	Launch	QS launched
2017			

